

PCI/104-ExpressTM & & PCIe/104TM Specification

Including OneBankTM and Adoption on 104TM, EPICTM, and EBXTM Form Factors

Version 3.0

February 17, 2015

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REVISION HISTORY

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Initial release

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 Add USB and over current signal to pin out, inserted description in 1.4.4, modified shift example to include USB

- Section 2.4 corrected that even numbered pins are located towards the inside of the board and odd numbered pins are located towards the edge of the board
- PEx16 ENA changed to PEG ENA# in section 2.4.1.2 and 2.4.3
- Figure 2.3 Moved Host to bottom in this figure and added USB
- Figure 6-14 Top two boards are PCI/104-Express

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- Added Type 2 connector version
- Added 22mm connector option
- Removed Figure 6 4: Mating of Top Half and Bottom Half of Connector A because this nondimensioned sketch provided no useful information
- Editorial changes:
 - Changed signal names PWRGD to PWRGOOD, CPU_DIR to DIR, and 5V_Always to +5V_SB for consistency
 - Corrected USB0 and USB1 in Automatic Link Shifting Examples for Host and Various Devices
 - o Corrected text in Appendix B and C related to PCI/104-Express Expansion Zone
 - Redrew Example breakout routing of connector bank 1 PCI Express x1 links with shifting
 - o Changed PCIe to PCI Express when discussing the PCI Express specification.
 - o Cleaned up drawings in Figure 1-1
 - O Swapped order of section 1.3 and 1.4 and edited text
 - Fixed missing references.
 - Added signal switches suggestions for SATA and USB 3.0

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• Provided SATA definitions that were omitted in previous version.

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- Corrected Consortium name in all references
- Expanded introduction to PCI Express to include Gen 1, 2, and 3.
- Added PCI Express Gen 2 recommendations.
 - o Added devices and updated signal switch table.
 - o Updated layout recommendations section to include PCIe Gen 2 & 3.
 - o Added Gen 2 & 3 to via and trace length table.
 - Removed microstrip and stripline examples.
- Added PCI Express x4, x8, and x16 layout examples.
- Added SATA and USB 3.0 capacitor info and layout examples.
- Changed SDVO to Alternate Function

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- Added OneBankTM connector variation
- Updated connector mechanical performance specifications
- Cleaned up Link Shifting wording
- Added stitching capacitors to first bank of PCIe/104 connector

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Glossary of Terms

Terms	Definitions
ATX	Advanced Technology Extended
	A specification for PC motherboards, power supplies, and system chassis. One of its most notable features is support for "Standby" and "Soft-Off" power savings modes.
Device	A logical device attached to a PCI Express Link. Generally an add-in card.
DMA	Direct Memory Access
	A method for peripherals to efficiently access system memory without CPU intervention.
EBX	Form factor for SBC's
Host	The central connection of a PCI Express system, typically a CPU module. This is called the "Root Complex" by the PCI Express specification.
ISA Bus	Industry Standard Architecture
	A legacy bus used on earlier PCs. It has been phased out of desktop PCs, but is still common in embedded systems.
Lane	Fundamental unit of a PCI Express connection. A set of differential signal pairs, one pair for transmission, and one pair for reception. Multiple lanes may be combined to increase bandwidth (up to x16). A "by-N Link" is comprised of N Lanes.
Link	The collection of one or more PCI Express Lanes, plus an additional differential pair for a clock, which make up a standard PCI Express interconnect. According to PCI Express Specification 1.1 a Link can be comprised of 1, 4, 8, or 16 Lanes.
Packet Switch	A device used to attach multiple PCI Express devices to a single link on the HOST. The PCI Express Specification refers to this simply as a "Switch." In this document, the term "Packet Switch" is used to differentiate from a "Signal Switch."
PCIe	PCI Express
PEG	PCI Express Graphics
SBC	Single Board Computer
SDVO	Serial Digital Video Output used from Intel 915/945/965 chipsets
Signal Switch	An analog switch used to select between multiple PCI Express devices to attach to a single PCI Express link, or multiple links to attach to a single device. Also called a "Channel Switch."
SMBus	System Management Bus
USB	Universal Serial Bus
LPC	Low pin count bus, a bus specification for legacy devices
SATA	Serial ATA Bus

1. INTRODUCTION

1.1. Purpose

This document defines the addition of PCI Express, the next generation serial interconnect bus, to the stackable 104, EPIC, and EBX form factors. PCI Express was chosen because of its performance, scalability, wide market acceptance, and growing silicon availability worldwide. The PCI Express architecture uses familiar software and configuration interfaces of the conventional PCI bus architecture, but provides a new high-performance physical interface while retaining software compatibility with the existing conventional PCI infrastructure.

PCI Express is a high performance I/O architecture used in both desktop and mobile applications. This hierarchical, point-to-point interconnect works well with on-board and slot oriented architectures. The purpose of this Specification is to adapt PCI Express to the stacked architecture employed with 104, EPIC and EBX form factors.

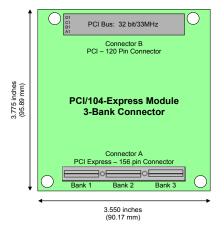
1.2. Standard Identification

A PCI-104 board with the addition of PCI Express becomes PCI/104-Express. A board with only the PCI Express connector is called PCIe/104. Each of these configurations can be applied to EPIC and EBX as shown in Appendix B and C. This allows full interchangeability with add-in devices across all PC/104 form factors.

1.3. Description

As computer technology continues to develop, the PC/104 community must expand to the new, widely accepted and sustained technologies of the day. The PCI/104-Express Specification provides this next generation PC/104 platform with a connector architecture that provides high-speed interfaces, maintains the ability to develop low-cost modules, and is sustainable for the foreseeable future.

Key to its development was obtaining a high speed, 3-bank, stackable PCI Express connector for both up and down stacking, while retaining the stackable PCI connector for backward compatibility to PCI-104, PC/104-*Plus*, and PC/104 peripheral modules. Figure 1-2 shows a basic view of the PCI/104-Express and PCIe/104 layouts.



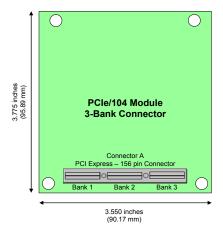
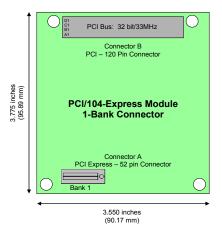


Figure 1-1: PCI/104-Express and PCIe/104 Board Layouts on 104 Form Factor

A reduced feature set OneBank version does not implement the Bank 2 or Bank 3 connectors. Figure 1-2 shows the same basic views with the OneBank connector.



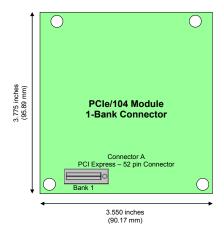


Figure 1-2: OneBank Connector PCI/104-Express and PCIe/104 Board Layouts on 104 Form Factor

ISA bus backward compatibility can naturally and easily be achieved with the use of a PCI-to-ISA bridge peripheral module (see Appendix A).

1.4. PCIe/104 Type 1 and Type 2

PCIe/104 is implemented by a pair of high-speed surface mount connectors. If the host CPU has top and bottom connectors electrically connected together then the system can be built either stack-up or stack-down, but not both at the same time. However, there is no requirement for the connector on the top of the host to be electrically connected to the connector on the bottom of the host. This means that a PCIe/104 bus stacking up can be completely separate from PCIe/104 bus going down. The specification does require all peripheral boards to be universal, so all peripheral boards will work either above or below the CPU.

This specification defines two versions of the PCIe/104 connector pin out, Type 1 and Type 2. Type 1 is the same versions 1.0 and 1.1 of the PCI/104-Express and PCIe/104 specification. Type 2 replaces the PCI Express x16 link with two PCI Express x4 links, two USB 3.0, two SATA, LPC, and an RTC battery. The OneBank implementation is compatible with the common Type 1 and Type 2 features. See Table 1-1 below for a comparison.

Feature	Type 1	Type 2	OneBank
USB 2.0	2	2	2
SMB	1	1	1
PCle x1	4	4	4
Power	+3.3V, +5V, +12V	+3.3V, +5V, +12V	+3.3V, +5V
ATX Control	Yes	Yes	Yes
PCle x4		2	
PCle x16*	1		
USB 3.0		2	
SATA		2	
LPC		1	
RTC Battery		1	

Table 1-1 Feature Summary

1.4.1 PCI/104-Express Version 1.0 and 1.1 Host Board Compatibility

All host boards built to PCI/104-Express version1.0 and 1.1 are considered Type 1.

^{*} x16 Link can be used as x8 or x4, see Section 2.4.1.1.

1.4.2 PCI/104-Express Version 1.0 and 1.1 Peripheral Board Compatibility

All PCI Express x1, USB 2.0, and SMBus boards build to version 1.0 or 1.1 are considered Universal boards and will work unchanged on either Type 1 or Type 2 host CPUs. PCI Express x16 peripherals work only on Type 1 hosts. USB 3.0, SATA, and LPC peripherals will work only on Type 2 hosts.

The pin assignments on Bank 1 of the connector is exactly the same in Type 1 and Type 2, therefore all the PCI Express x1, USB 2.0, SMBus, and all the control signals are the same. Likewise all power and grounds are the same throughout the connector.

1.5. PCIe/104 Feature Set

1.5.1 Connector A: PCI Express Bus

PCIe/104 Type 1, Type 2 and the OneBank implementation have this common feature set and pin assignments:

Four x1 PCI Express Links

Two USB 2.0

ATX power and control signals: +5V Standby, Power supply on, Power OK

Power: +3.3V, +5V, +12V (A OneBank implementation does not include +12V)

SMBus

Type 1 has the common feature set plus:

One x16 PCI Express Link, or optionally two x8 Links, or two x4 PCI Express Links

Type 2 has the common feature set plus:

Two x4 PCI Express Links

Two USB 3.0

Two SATA

LPC Bus

RTC Battery

1.6. PCI/104-Express Feature Set

1.6.1 Connector A : Same as 1.5.1 above

1.6.2 Connector B: PCI Bus:

PCI Bus: 32 bit, 33 MHz, Four Bus Master capable (same as on PC/104-Plus and & PCI-104)

+5V Standby, Power supply on, and power management event signals for ATX power supply

Power: +3.3V, +5V, +12V, -12V

Same location and pin out as PCI-104 and PC/104-Plus specifications

1.7. General Stacking Rules

This specification defines Type 1 and Type 2 host and peripheral modules. There are four stacking rules.

Peripheral modules connecting with PCI Express x1 or x4 links, USB 2.0 links, or SMB are universal and can plug into either a Type 1 or a Type 2 host.

Peripheral modules connecting with PCI Express x16 or x8 links must plug into a Type 1 host.

Peripheral modules connecting with SATA, USB 3.0, or LPC links must plug into a Type 2 host.

Any peripheral module plugged in the wrong bus holds the system in reset and causes no damage.

Guidelines for stacking PCI Express Gen 1, 2, 3, USB 3.0, and SATA.

- Build a stack by putting higher clock rate peripherals closer to the host. Follow the priority below:
 - 1. Gen 3 PCI Express at 8.0 Gigabits/second closest to the host
 - 2. SATA 3 at 6.0 Gigabits/second next closest
 - 3. Gen 2 PCI Express and USB 3.0 at 5.0 Gigabits/second
 - 4. SATA 2 at 3.0 Gigabits/second
 - 5. Gen 1 PCI Express at 2.5 Gigabits/second

- 6. SATA 1 at 1.5 Gigabits/second
- 7. USB 2.0 at 480 Mbits/second
- Follow the guidelines for up and down stacking in Table 1-2 Type 1 & Type 2 Combinations below.

For example, if you have a host with a Type 1 stacking down and a Type 2 stacking up with one SATA 2, one USB 3.0, one PCI Express x1 Gen 2, two PCI Express x1 Gen 1, and one PCI Express x16 Gen 2 peripherals your stack could be configured as:

- SATA peripheral
- USB 3.0 peripheral
- Host (Type 1 going down and Type 2 going up)
- PCI Express x16 Gen 2 peripheral
- PCI Express x1 Gen 2 peripheral
- PCI Express x1 Gen 1 peripheral
- PCI Express x1 Gen 1 peripheral

For details on host and peripheral configuration see section 4, PCIe/104 Type 1 and Type 2 Stacking.

1.8. Stack Up, Stack Down, and Both

If the host CPU has the same type connector on top and bottom of the board and the signals are connected together, boards can be stacked either up or down using the direction signal DIR to indicate to the peripheral board where the host is located. In this case, care must be taken not to stack boards in both directions because signal stubs will be created which may adversely affect the bus signals.

Surface mounted connectors permit the top and bottom connectors to be separate busses. If the host CPU is built with separate busses on top and bottom there will not be stubs when stacking cards both up and down at the same time. This specification supports connected or separate bus options as long as board configuration rules are followed. Table 1-2 shows the maximum number of links for all the possible combinations.

PCIe/104 Type 1		Type 2		Type 1 & 2 Combo		
Top and Bottom Connectors Connected Separate		Connected	Separate	Connected	Separate	
Peripheral Board Stacking	Either up or down	Both up and down	Either up or down	Both up and down		Both up and down
x1 PCle Links	4	8	4	8		8
USB 2.0	2	4	2	4		4
SMB	1	1	1	1		1
x4 PCle Links	2	4	2	4	Not Allowed	4
x8 PCle Links	2	4	None	None	Not Allowed	2
x16 PCle Links	1	2	None	None		1
SATA	None	None	2	4		2
USB 3.0	None	None	2	4		2
LPC	None	None	1	1		1

Table 1-2 Type 1 & Type 2 Combinations

1.9. Bus and Signal Group Descriptions

1.9.1 PCI Express Expansion Bus

PCI Express is a high performance, general purpose I/O interconnect defined for a wide variety of future computing and communication platforms. Key PCI attributes, such as its usage model, load-store architecture, and software interfaces, are maintained, whereas its parallel bus implementation is replaced by a highly scalable, fully serial interface. PCI Express takes advantage of recent advances in point-to-point interconnects, Switch-based technology, and packet-protocol to deliver new levels of performance and features. Power Management, Quality of Service (QoS), Hot-Plug/Hot-Swap support, Data Integrity, and Error Handling are among some of the advanced features supported by PCI Express. PCI Express has three signaling rates.

- Generation 1, Gen 1, is 2.5 Gigabits/second/Lane/direction of raw bandwidth
- Generation 2, Gen 2, is 5.0 Gigabits/second/Lane/direction of raw bandwidth
- Generation 3, Gen 3, is 8.0 Gigabits/second/Lane/direction of raw bandwidth

PCI/104-Express and PCIe/104 incorporate four x1 PCI Express Links and options for either a single x16 Link, or two x8 Links, or two x4 PCI Express Links to allow connections to standard PCI Express device chips. The x16 Link option allows maximum flexibility, configurability, and expandability for current and future designs. Some examples of x16 Link application are next generation graphics chips, 1/10 gigabit Ethernet chips, or use with a PCI Express Switch which can then branch the high throughput out into any number of various size Links including multiple x16 Link graphics engines. The only limitation is the bandwidth requirement for each of the branched links.

1.9.1.1 PCI Express x16 or PEG Link

PCI Express x16, sometimes called PEG (PCI Express for Graphics), is an interface with 16 PCI Express differential lanes to connect a high performance video controller or other high bandwidth devices. In chipsets with internal graphics, the PEG bus is used as an alternative to connect an external video controller. The internal chip controller is disabled in this case. The PEG-Bus configuration must be enabled from the Device by connecting the PEG-ENA# signal to ground.

1.9.1.2 Non-PCI Express functions of the CPU/Chipset x16 Link

Some processors/chipsets allow alternate functions on the x16 link pins. There is no standard which all manufacturers follow, so this specification will not define one. Using these alternate functions is allowed, but it is up to the host board manufacturer to define the alternate uses and what peripheral boards are compatible. Use of the PEG-ENA# shall remain open on these peripheral boards.

One example of this is Serial Digital Video Output (SDVO). This bus is provided as an alternative to the PEG-Bus on some CPU chipsets. SDVO-Links needs up to 7 differential signal pairs per interface.

1.9.2 SATA Links

Serial ATA (SATA or Serial Advanced Technology Attachment) is a computer bus interface for connecting host bus adapters to mass storage devices such as hard disk drives and optical drives. Serial ATA was designed to replace the older ATA (AT Attachment) standard (also known as EIDE). It is able to use the same low level commands, but serial ATA host-adapters and devices communicate via a high-speed serial cable over two pairs of conductors. Support for device detection and power enable for hot-pluggable applications.

1.9.3 LPC Bus

The Low Pin Count bus, or LPC bus, is used on IBM-compatible personal computers to connect low-bandwidth devices to the CPU, such as the boot ROM and the "legacy" I/O devices. The "legacy" I/O devices usually include serial and parallel ports, keyboard, mouse, and floppy disk controller.

The LPC bus was introduced by Intel in 1998 as a substitute for the Industry Standard Architecture (ISA) bus. It resembles ISA to software, although physically it is quite different, replacing the 16-bit-wide, 8.33 MHz ISA bus with a 4-bit-wide bus operating at 4 times the clock speed (33.3 MHz). LPC's main advantage is that it requires only seven signals.

1.9.4 Universal Serial Bus (USB)

The USB is specified to be an industry-standard extension to the PC architecture with a focus on PC peripherals that enable consumer and business applications. The following criteria were applied in defining the architecture for the USB:

- Ease-of-use for PC peripheral expansion.
- USB 2.0 is a low-cost solution that supports transfer rates up to 480Mb/s.
- USB 3.0 is a high-speed solution with speeds up to 4800Mb/s
- Full support for real-time data of voice, audio, and video.
- Protocol flexibility for mixed-mode isochronous data transfers and asynchronous messaging.
- Integration in commodity device technology.
- Comprehension of various PC configurations and form factors.
- Provision of a standard interface capable of quick diffusion into a product.
- Enabling new classes of devices that augment the PC's capability.
- Full backward compatibility of USB 2.0 for devices built to previous versions of the specification.

The over-current protection is made on each PCI/104-Express peripheral board, if needed. Any channel can pull the OC#-Signal low to indicate the CPU host that an over-current situation has occurred.

1.9.5 System Management Bus

The optional System Management Bus (SMBus) is a two-wire interface through which various system component chips can communicate with each other and with the rest of the system. It is based on the principles of operation of I2C. SMBus provides a control bus for system- and power-management related tasks. A system may use SMBus to pass messages to and from devices instead of tripping individual control lines. Removing the individual control lines reduces pin count. Accepting messages ensures future expandability. With SMBus, a device can provide manufacturer information, tell the system what its model/part number is, save its state for a suspended event, report different types of errors, accept control parameters, and return its status. SMBus is described in System Management Bus (SMBus) Specification, Version 2.0. Refer to this specification for DC characteristics and all AC timings. If the system board or add-in card supports SMBus, it must adhere to additional requirements that may be found in Chapter 8 of the PCI Local Bus Specification, Revision. 3.0.

An address resolution protocol (ARP) is defined in the SMBus 2.0 Specification that is used to assign slave addresses to SMBus devices. Although optional in the SMBus 2.0 Specification, it is required that systems that connect the SMBus to PCI slots implement ARP for assignment of SMBus slave addresses to SMBus interface devices on PCI add-in cards. The system must execute ARP on a logical SMBus whenever any PCI bus segment associated with the logical SMBus exits the B3 state or a device in an individual slot associated with the logical SMBus exits the D3cold state. Prior to executing ARP, the system must insure that all ARP-capable SMBus interface devices are returned to their default address state.

The system board provides pull-ups to the +3.3Vaux rail per the above specification and the components attached to these signals need to have a 3.3V signaling tolerance (5V signaling must not be used). Also, the SMBus is used during all power states, so all components attached to the SMBus must remain powered during standby, or ensure that the bus is not pulled down when not powered.

The SMBus interface is based upon the System Management Bus Specification (SMBus 2.0 Specification). This two-wire serial interface has low power and low software overhead characteristics that make it well suited for low-bandwidth system management functions.

The capabilities enabled by the SMBus interface include, but are not limited to, the following:

Support for client management technologies.

Support for server management technologies.

Support for thermal sensors and other instrumentation devices on add-in cards.

Add-in card identification when the bus is in the B3 state or when the PCI device is in the D3hot or D3cold states as defined in the PCI Power Management Interface Specification.

1.9.6 ATX and Power Management

PCI/104-Express and PCIe/104 incorporate all of the necessary control and signal lines for ATX and power management functionalities. These signals include PWRGOOD, PSON#, +5V_SB, and PME#. The inclusion of these signals allows maximum power savings.

PWRGOOD is a "power good" signal. It should be asserted high by the power supply to indicate that the +12 VDC, +5 VDC, and +3.3 VDC outputs are above the under-voltage thresholds and that sufficient main energy is stored by the converter to guarantee continuous power operation within specifications. Conversely, PWRGOOD should be de-asserted to a low state when any of the +12 VDC, +5 VDC, or +3.3 VDC output voltages falls below its under-voltage threshold, or when main-power has been removed for a sufficiently long enough time that the power supply operation cannot be guaranteed beyond the power-down warning time.

PSON# is an active-low, TTL-compatible signal that allows a motherboard to remotely control the power supply in conjunction with features such as soft on/off, wake-on-LAN, or wake-on-modem. When PSON# is pulled to TTL low, the power supply should turn on the five main DC output rails: +12 VDC, +5 VDC, +3.3 VDC, -5 VDC, and -12 VDC. When PSON# is pulled to TTL high or open-circuited, the DC output rails should not deliver current and should be held at zero potential with respect to ground. PSON# has no effect on the +5V_SB output, which is always enabled whenever AC power is present. PSON# shall be pulled to +5V_SB with a 10K ohm resistor on the power supply.

+5V_SB is a standby supply output that is active whenever AC power is present. It provides a power source for circuits that must remain operational when the five main DC output rails are in a disabled state. Example uses include soft power control, wake-on-LAN, wake-on-modem, intrusion detection, or suspend state activities.

1.9.7 RTC Battery

Any board in a system can provide a 3.0 to 3.6 volt battery on pin 154 of the Type 2 connector. This battery shall be current limited with a $1K\Omega$ resistor, reverse current protected with a schottky diode, and filtered with a 10uF capacitor. Any board in the system may use the battery. Battery life will depend on the specific battery used and the load.

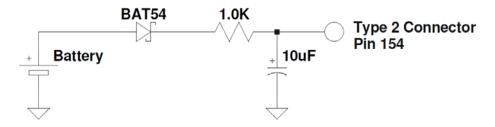


Figure 1-3 RTC Battery Example

1.9.8 PCI Expansion Bus

The PCI Expansion Bus is the same 32 bit, 33 MHz PCI bus found on the PC/104-Plus and PCI-104 Specifications with the addition of +5V_SB, PSON#, and PME#.

1.10. References

The following documents should be used as reference for a detailed understanding of the overall system requirements. For latest revisions of the above specifications contact the respective organizations.

PC/104 Specification	PC/104 Consortium	www.pc104.org
PC/104-Plus Specification	PC/104 Consortium	www.pc104.org
PCI-104 Specification	PC/104 Consortium	www.pc104.org
PCI Local Bus Specification Revision 2.2	PCI Special Interest Group	www.pcisig.com
PCI Express Base Specification Revision 1.1	PCI Special Interest Group	www.pcisig.com
ATX Specification Version 2.2	Intel Corporation	www.intel.com
System Management Bus (SMBus) Specification Version 2.0	SBS Implementers Forum	www.sbs-forum.org
INTEL description of PEG and SDVO in the 915/945/965 chipsets	Intel	www.intel.com
USB Specification Revision 2.0 USB Specification Revision 3.0	USB Implementers Forum	www.usb.org

If errors are found in this document, please send a written copy of the suggested corrections to the publishers listed on the title page.

2. EXPANSION CONNECTOR A

2.1. Functions

Not all processors and chipsets support all features on the PCIe/104 connectors, and in some cases the design of the Host may consume some or all of these features, rendering them unavailable. It is up to the Host designer to determine the type and number of features included on the expansion connector. For cases where the host provides less than the maximum number of features supported by the connector, see Section 2.4.4.

2.1.1 PCIe/104 Type 1 and Type 2 Common Features

PCIe/104 Type 1, Type 2 and the OneBank implementation have this common feature set

- Four x1 PCI Express Links
- Two USB 2.0
- ATX power and control signals: +5V Standby, Power supply on, Power OK
- Power: +3.3V, +5V, +12V (A OneBank implementation does not include +12V)
- SMBus

2.1.2 PCIe/104 Type 1 Only Additional Features

One x16 PCI Express Link, or optionally two x8 Links, or two x4 PCI Express Links

2.1.3 PCIe/104 Type 2 Only Additional Features

Two PCI Express x4 Links Two USB 3.0 Two SATA LPC Bus RTC Battery

2.2. Signal Descriptions

2.2.1 PCIe/104 Type 1

Table 2-1 Connector A Type 1 Signals

Group	Pins	Signal Name	Host Direction	Description
	4	PEx1_[0:3]Tp	Output	Transmit Differential Upper Line for x1 Links 0, 1, 2, 3. Shifted when used.
		PEx1 [0:3]Tn	Output	Transmit Differential Lower Line for x1 Links 0, 1, 2, 3. Shifted when used.
DCI 1		PEx1_[0:3]Rp	Input	Receive Differential Upper Line for x1 Links 0, 1, 2, 3. Shifted when used.
PCIe x1		PEx1 [0:3]Rn	Input	Receive Differential Lower Line for x1 Links 0, 1, 2, 3. Shifted when used.
	4	PEx1_[0:3]CLKp	Output	Clock Differential Upper Line for x1 Links 0, 1, 2, 3. Shifted when used.
	4	PEx1_[0:3]CLKn	Output	Clock Differential Lower Line for x1 Links 0, 1, 2, 3. Shifted when used.
	8	PEx4_[0:1]T(#)p	Output	Transmit Differential Upper Lines for the x4 Links. The x4 Links should be shifted when used.
	8	PEx4_[0:1]T(#)n	Output	Transmit Differential Lower Lines for x4 Links. The x4 Links should be shifted when used.
PCIe x4	8	PEx4_[0:1]R(#)p	Input	Receive Differential Upper Lines for the x4 Links. The x4 Links should be shifted when used.
	8	PEx4_[0:1]R(#)n	Input	Receive Differential Lower Lines for the x4 Links. The x4 Links should be shifted when used.
	1	PEx16_x8_x4_CLKp	Output	Clock Differential Upper Line for x16 or first x8 or x4 Link. Re-driven when used
	1	PEx16_x8_x4_CLKn	Output	Clock Differential Lower Line for x16 or first x8 or x4 Link. Re-driven when used
	16 16	PEx16_0T(#)p PEx8_[0:1]T(#)p	Output	Transmit Differential Upper Lines for the x16, x8 or the x4 Links. The x8 Links should be shifted when used.
		PEx16_0T(#)n PEx8_[0:1]T(#)n	Output	Transmit Differential Lower Lines for x16, x8 or the x4 Links. The x8 Links should be shifted when used.
PCIe x16 or PCIe x8	16	PEx16_0R(#)p PEx8_[0:1]R(#)p	Input	Receive Differential Upper Lines for the x16, x8, or the x4 Links. The x 8 Links should be shifted when used.
	16	PEx16_0R(#)n PEx8_[0:1]R(#)n	Input	Receive Differential Lower Lines for the x16, x8, or the x4 Links. The x8 Links should be shifted when used.
	1	PEx16_x8_x4_CLKp	Output	Clock Differential Upper Line for x16 or first x8 or x4 Link. Re-driven when used
	1	PEx16_x8_x4_CLKn	Output	Clock Differential Lower Line for x16 or first x8 or x4 Link. Re-driven when used
Stacking	1	STK0/WAKE#	Input	Stacking bit 0/Wake on LAN
Control	1	STK1/SDVO_DAT	In/Out	Stacking bit 1/SDVO Data
Control	1	STK1/PEG_ENA#	Input	Stacking bit 2/x16 Link or Alternate Function Enable
	2	USB_[1:0]p	Bidirectional	Differential Upper Lines for USB 2.0 Links 0, 1. Shifted when used.
USB 2.0	- 1	USB_[1:0]n		Differential Lower Lines for USB 2.0 Links 0, 1. Shifted when used.
	1	USB_OC	Input	Over-current detect for USB. Pulled low by device.
Misc.	1	DIR	Output	Direction indicates to the Device if it is installed above or below the Host. Bypass with a 0.01uF capacitor to ground as close as possible to the pin.
PCIe	1	PERST#	Output	Reset for PCI Express Bus
	1	PSON#	Output	Power Supply On brings the ATX power supply out of sleep mode. Bypass with a 0.01uF capacitor to ground as close as possible to the pin.
ATX	1	PWRGOOD	Input	Power Good from the power supply indicates power is good Bypass with a 0.01uF capacitor to ground as close as possible to the pin.
Power Supply	2	+5V_SB	Power	Standby Power for advanced power saving modes. Always on Bypass with a 0.01uF capacitor to ground as close as possible to the pin.
Suppry	2	+5V	Power	+5V central power planes
	2	+3.3V	Power	+3.3V power
	1	+12V	Power	+12V central power plane
		GND	Power	GND pins
C) (D)	1	SMB_Clk	Output	Clock for SMBus
SMB	1 1	SMB_Data	Bidirectional	Data for SMBus
	1	SMB_Alert#	Input	Alert for SMBus
		cates the lane within a		
		ndicates link 0, 1, 2, or	3	
11 0 1 1		ndicates link 0 or 1	1	unctional groups, for the various buses housed in Connector A Type 1

Table 2-1 shows only the required pins, arranged in functional groups, for the various buses housed in Connector A Type 1. This version of the stackable PCI Express is as defined in the *PCIe Base Specification Revision 1.1* with the exception that Hot plug present detect, Hot plug detect, and JTAG are not supported.

2.2.2 PCIe/104 Type 2

Table 2-2 Connector A Type 2 Signals

	Pins	Signal Name	Host Direction	Description
	4	PEx1_[0:3]Tp	Output	Transmit Differential Upper Line for x1 Links 0, 1, 2, 3. Shifted when used.
	4	PEx1 [0:3]Tn	Output	Transmit Differential Lower Line for x1 Links 0, 1, 2, 3. Shifted when used.
DCI 1	4	PEx1 [0:3]Rp	Input	Receive Differential Upper Line for x1 Links 0, 1, 2, 3. Shifted when used.
PCIe x1	4	PEx1_[0:3]Rn	Input	Receive Differential Lower Line for x1 Links 0, 1, 2, 3. Shifted when used.
		PEx1_[0:3]CLKp	Output	Clock Differential Upper Line for x1 Links 0, 1, 2, 3. Shifted when used.
	4	PEx1_[0:3]CLKn	Output	Clock Differential Lower Line for x1 Links 0, 1, 2, 3. Shifted when used.
	8	PEx4_[0:1]T(#)p	Output	Transmit Differential Upper Lines for the x4 Links. The x4 Links should be shifted when used.
	8	PEx4_[0:1]T(#)n	Output	Transmit Differential Lower Lines for x4 Links. The x4 Links should be shifted when used.
PCIe x4	8	PEx4_[0:1]R(#)p	Input	Receive Differential Upper Lines for the x4 Links. The x4 Links should be shifted when used.
		PEx4_[0:1]R(#)n	Input	Receive Differential Lower Lines for the x4 Links. The x4 Links should be shifted when used.
		PEx16_x8_x4_CLKp	Output	Clock Differential Upper Line for x16 or first x8 or x4 Link. Re-driven when used
			Output	Clock Differential Lower Line for x16 or first x8 or x4 Link. Re-driven when used
		SATA_T[0:1]p	Output	Transmit Differential Upper Line for SATA Links 0 and 1. Shifted when used.
		SATA_T[0:1]n	Output	Transmit Differential Lower Line for SATA Links 0 and 1. Shifted when used.
		SATA_R[0:1]p	Input	Receive Differential Upper Line for SATA Links 0 and 1. Shifted when used.
SATA	4	SATA_R[0:1]n	Input	Receive Differential Lower Line for SATA Links 0 and 1. Shifted when used.
SATA	2	SATA_DET#[0:1]	Input	Active low input to the host to indicate that a drive is attached. Only used in hot-pluggable applications. Pull up to +3.3V at the host. Ground at the device when it is attached. High impedance at the device when it is not attached, or when the drive is going to be removed. Shifted along with the other SATA signals. Optional.
	2	SATA_PWREN#[0:1]	Output	Active low output from the host to enable power to the device. Only used in hot-pluggable applications. Pull up to +3.3V at the device. Assert low at the host when the device is to be powered (i.e. in response to SATA_DET# being asserted). Shifted along with the other SATA signals. Optional.
Q. 1:	1	STK0/WAKE#	Input	Stacking bit 0/Wake on LAN
Stacking Control	1	STK1/SDVO_DAT	In/Out	Stacking bit 1/SDVO Data
Control	1	STK1/PEG_ENA#	Input	Stacking bit 2/x16 Link or Alternate Function Enable
	2	USB_[1:0]p	Bidirectional	Differential Upper Lines for USB 2.0 Links 0, 1. Shifted when used.
USB 2.0	2	USB_[1:0]n	Bidirectional	Differential Lower Lines for USB 2.0 Links 0, 1. Shifted when used.
	1	USB_OC	Input	Over-current detect for USB. Pulled low by device.
	2	SSTX_[0:1]p	Output	Transmit Differential Upper Line for USB 3.0 Links 0, 1. Shifted when used.
USB 3.0	2	SSTX _[0:1]n	Output	Transmit Differential Lower Line for USB 3.0 Links 0, 1. Shifted when used.
OSD 3.0	2	SSRX _[0:1]p		Receive Differential Upper Line for USB 3.0 Links 0, 1. Shifted when used.
		SSRX _[0:1]n	Input	Receive Differential Lower Line for USB 3.0 Links 0, 1. Shifted when used.
Misc.	1	DIR	Output	Direction indicates to the Device if it is installed above or below the Host
PCIe	1	PERST#	Output	Reset for PCI Express Bus
		PSON#	Output	Power Supply On brings the ATX power supply out of sleep mode.
	1	PWRGOOD	Input	Power Good from the power supply indicates power is good
ATX	2	+5V_SB	Power	Standby Power for advanced power saving modes. Always on
Power	2	+5V	Power	+5V central power planes
Supply	2			+3.3V power
~~pp1j	1	+12V		+12V central power plane
		RTC_Battery	Power	Battery for real time clock (with diode, series resistor, and capacitor)
		GND	Power	GND pins
		SMB_Clk	Output	Clock for SMBus
SMB		SMB_Data	Bidirectional	Data for SMBus
		SMB_Alert#	Input	Alert for SMBus
Reserved		Reserved		Reserved – Do not make any connection to these pins
		cates the lane within a		
	[0:3] i	ndicates link 0, 1, 2, or	3	
11 220		ndicates link 0 or 1	-1 1 41-	

Table 2-2 Connector A Type 2 Signals shows only the required pins, arranged in functional groups, for the various buses housed in Connector A Type 2. This version of the stackable PCI Express is as defined in the *PCIe Base Specification Revision 1.1* with the exception that Hot plug present detect, Hot plug detect, and JTAG are not supported.

2.3. Signal Naming Convention

The PCI Express signals on Connector A are named so that signal groupings are obvious. The fields in a signal name go from general to specific. The PCI Express signals start with the characters "PE," followed by the width of the Link ("x1", "x4", "x8", or "x16"), followed by an underscore "_". Next is the Link number if there is more than one Link of that width. Then is either "T", "R", or "Clk" for Transmit, Receive, or Clock respectively. Next is the lane number in the link

in parenthesis, for the links that have more than one lane. Last is "p" or "n" for the positive and negative signal in the differential pair.

For example, Pex4_0T(2)p is the positive signal in lane number 2 of the first x4 Link.

A signal on the connector is designated "transmit" or "receive" in a Host-centric manner. The "transmit" pin on the Host connects to the "T" (transmit) pin of the connector. From there, the signal connects to "receive" pin of the Device.

In a PCI Express system the transmit pins of the chip are always connected to the receive pins of the other chip in the link, and vice-versa. For example, for a specific link, transmit on the Host chip is connected to receive on the Device chip, and receive on the Host is connected to transmit on the Device.

Other non-PCI Express signals follow a similar convention.

2.4. Pin Assignment

On both of these connectors, the odd-numbered pins are located towards the edge of the board, and the even numbered pins are located towards the inside of the board. Signals were assigned to pins to simplify breakout and reduce trace lengths of the PCI Express signals around Connector A. See Table 2-3 for Type 1 and Table 2-4 for Type 2 pin assignments.

Table 2-3 Connector A, Type 1 Pin Assignments

1.58 10 1.58 10 1.58 10 1.58 10 1.58 10 1.58 10 1.58 10 1.58	_				_			5 " "			
3 3 33V 4 6 1 188 pp 6	L.		gna				L-		Sign		
S. U.S.B. 1p O.S.B.				_							1
7											3
9 OND 10 PR-L_TITO 12 PR-L_TITO 13 PR-L_TITO 14 PR-L_TITO 14 PR-L_TITO 14 PR-L_TITO 15 OND 16 PR-L_TITO 17 OND 16 PR-L_TITO 16 OND 16 PR-L_TITO 17 OND 16 PR-L_TITO 17 OND 16 PR-L_TITO 17 OND 16 PR-L_TITO 17 OND 18 PR-L_TITO 18 OND 18	5	USB_1p		USB_0p			6	USB_0p		USB_1p	5
Text_UTip	7	USB_1n		USB_0n	8		8	USB_0n		USB_1n	7
Table Pack Trin Table Ta	9	GND		GND	10		10	GND		GND	9
Text_Units	11	PEx1_1Tp		PEx1_0Tp	12		12	PEx1_0Tp		PEx1_1Tp	11
15	13			PEx1_0Tn	14		14	PEx1_0Tn			13
Text				_							15
PEXT_STR											17
23	_										
FEST, 1/RP 25 FEST, 1/RP 26 FEST, 1/RP 27 FEST, 1/RP 28 FEST, 1/RP FE		_		_			_				19
FRAT_URN											21
20	23		"	PEx1_0Rp	24	_	24			PEx1_1Rp	23
27 PEL CRO 17 PEL CRO 18 PEL CRO 18 PEL CRO 19 PEL CRO	25	PEx1_1Rn	#	PEx1_0Rn	26	<u>×</u>	26	PEx1_0Rn	 	PEx1_1Rn	25
29 FE41_RPh FE41_RPh Sub Sub FE41_RPh Sub Sub FE41_RPh Sub Sub FE41_RPh Sub Sub FE41_RPh Sub Sub FE41_RPh Sub FE41_RPh Sub Sub FE41_RPh Sub Sub FE41_RPh Sub Sub Sub FE41_RPh Sub Sub Sub Sub FE41_RPh Sub S	27	GND	× ×	GND	28	<u> </u>	28	GND	>	GND	27
STR FEXT 2Ph	29	PEx1 2Rp	Ŧ	PEx1 3Rp	30	ш	30	PEx1 3Rp	Ŧ	PEx1 2Ro	29
SS PELT_COXP PELT_COXP SE PELT_COXP SE PELT_COXP P	31										31
SECOND S	_										33
FR-1, Clown Se											35
19 +9V,SB											
A											37
1.5 PEXT_COM PEX	39	+5V_SB		+5V_SB	40		40	+5V_SB		+5V_SB	39
16	41	PEx1_2Clkp		PEx1_3Clkp	42		42	PEx1_3Clkp		PEx1_2Clkp	41
AT SME DAT	43	PEx1 2Clkn		PEx1 3Clkn	44		44	PEx1 3Clkn		PEx1 2Clkn	43
AP SME_CLK PEXTE_CRED A8 A9 SME_CLK PEXTE_CRED SO PEXTE_CRED PEX	_										45
SNE_CLK	_						-				47
SIND_ALERT											47
S3 STKO /WAKER STKI / PEG_BN# S4 STKI / PEG_BN# S5 STKO /WAKER S5 GND S6 FEXTE, 07(9)p S6 FEXTE, 07(9)p FEXTE, 07(10)p S6 FEXTE, 07(9)p FEXTE, 07(10)p S6 FEXTE, 07(9)p FEXTE, 07(10)p FE									l		
SE GND GND FExt GND SE FEXT GND	51	SMB_ALERT		PSON#	52		52	PSON#		SMB_ALERT	51
SE											
FEXTE0T(0)p FEXTE0T(0)	53	STK0 / WAKE#		STK1 / PEG_ENA#	54		54	STK1 / PEG_ENA#		STK0 / WAKE#	53
SE PEXT6_0T(9)n GND GN	55	GND		GND	56		56	GND		GND	55
FEXTB_0T(0)n FEXT	57	PEx16 0T(8)p		PEx16 0T(0)p	58		58	PEx16_0T(0)p		PEx16 0T(8)p	57
GND 62	59	PEx16_0T(8)n			60		60				59
FEXTE. 0.07(19) FEXTE. 0.0				_ ,							61
6.5 PEX16_0T(10)D 6.7 GND 6.8 PEX16_0T(10)D 7.1 PEX16_0T(10)D 7.2 GND 7.3 GND 7.5 PEX16_0T(11)D 7.5 PEX16_0T(11)D 7.6 PEX16_0T(11)D 7.7 PEX16_0T(11)D 7.8 GND 7.8 PEX16_0T(11)D 7.9 GND 8.1 PEX16_0T(12)D 8.5 GND 8.1 PEX16_0T(12)D 8.5 GND 8.7 PEX16_0T(12)D 8.8 PEX16_0T(12)D 8.8 PEX16_0T(12)D 8.8 PEX16_0T(12)D 8.8 PEX16_0T(12)D 8.8 PEX16_0T(12)D 8.8 PEX16_0T(12)D 8.9 PEX16_0T(13)D 9.1 GND 9.1 GND 9.1 GND 9.1 GND 9.1 GND 9.2 PEX16_0T(14)D 9.5 PEX16_0T(14)D 9.5 PEX16_0T(14)D 9.5 PEX16_0T(14)D 9.5 PEX16_0T(14)D 9.5 PEX16_0T(14)D 9.5 GND 9.6 GND 9.7 GND 9.8 PEX16_0T(14)D 9.8 PEX16_0T(14)D 9.8 PEX16_0T(13)D 9.8 PEX16_0T(14)D					_						_
ST											63
Fex16_0T(10)p		PEx16_0T(9)n					66			PEx16_0T(9)n	65
PEXT6_0T(10) PEXT	67	GND		GND	68		68	GND		GND	67
87 PEx16_OT(13)n 89 PEx16_OT(13)n 91 GND 91 GND 93 PEx16_OT(14)n 95 PEx16_OT(14)n 95 GND 95 PEx16_OT(14)n 96 PEx16_OT(6)n 97 GND 98 PEx16_OT(6)n 98 GND 99 PEx16_OT(15)n 101 PEx16_OT(15)n 103 GND 103 GND 104 GND 105 STK2 / SDVO_DAT 107 GND 109 PEx16_OT(6)n 100 PEx16_OT(7)n 101 PEx16_OT(8)n 101 PEx16_OT(8)n 102 PEx16_OT(7)n 103 GND 104 GND 105 STK2 / SDVO_DAT 107 GND 108 PEx16_OT(9)n 109 PEx16_OT(8)n 109 PEx16_OT(8)n 100 PEx16_OT(7)n 101 PEx16_OT(8)n 102 PEx16_OT(7)n 103 GND 104 GND 105 GND 107 GND 108 GND 109 PEx16_OT(8)n 109 PEx16_OT(8)n 100 PEx16_OT(9)n 101 PEx16_OT(8)n 100 PEx16_OT(9)n 101 PEx16_OT(8)n 102 PEx16_OT(9)n 103 GND 104 GND 105 GND 106 SDVO_CLK 106 SDVO_CLK 107 GND 108 GND 109 PEx16_OT(9)n 110 PEx16_OT(9)n 111 PEx16_OT(8)n 111 PEx16_OT(8)n 112 GND 114 GND 115 PEx16_OT(9)n 115 PEx16_OT(9)n 116 PEx16_OT(9)n 117 PEx16_OT(9)n 118 GND 119 GND 120 GND 121 GND 121 PEx16_OT(1)n 122 PEx16_OT(1)n 123 PEx16_OT(1)n 124 PEx16_OT(1)n 125 GND 126 GND 127 PEx16_OT(1)n 128 PEx16_OT(1)n 129 PEx16_OT(1)n 120 GND 121 PEx16_OT(1)n 121 PEx16_OT(1)n 122 PEx16_OT(1)n 123 PEx16_OT(1)n 124 PEx16_OT(1)n 125 GND 126 GND 127 PEx16_OT(1)n 128 PEx16_OT(1)n 129 PEx16_OT(1)n 120 GND 120 GND 121 PEx16_OT(1)n 121 PEx16_OT(1)n 122 PEx16_OT(1)n 123 PEx16_OT(1)n 124 PEx16_OT(1)n 125 GND 126 GND 127 PEx16_OT(1)n 128 PEx16_OT(1)n 129 PEx16_OT(1)n 120 GND	69	PEx16_0T(10)p		PEx16_0T(2)p	70		70	PEx16_0T(2)p		PEx16_0T(10)p	69
87 PEx16_OT(13)p 88 PEx16_OT(13)p 91 GND 92 PEx16_OT(14)p 93 PEx16_OT(14)p 95 PEx16_OT(14)p 95 PEx16_OT(14)p 96 PEx16_OT(16)p 97 GND 98 PEx16_OT(16)p 99 PEx16_OT(16)p 101 PEx16_OT(15)p 102 PEx16_OT(17)p 103 GND 104 GND 105 STK2 / SDVO_DAT 106 SDVO_CLK 107 GND 108 PEx16_OR(8)p 119 PEx16_OR(8)p 111 PEx16_OR(8)p 111 PEx16_OR(8)p 111 PEx16_OR(8)p 111 PEx16_OR(8)p 112 PEx16_OR(9)p 113 GND 115 PEx16_OR(9)p 116 PEx16_OR(9)p 117 PEx16_OR(9)p 118 GND 119 GND 120 PEx16_OR(10)p 121 PEx16_OR(10)p 122 PEx16_OR(10)p 123 PEx16_OR(10)p 124 PEx16_OR(10)p 125 GND 126 GND 127 PEx16_OR(10)p 128 PEx16_OR(10)p 129 PEx16_OR(10)p 120 GND 121 PEx16_OR(10)p 121 PEx16_OR(10)p 122 PEx16_OR(10)p 123 PEx16_OR(10)p 124 PEx16_OR(10)p 125 GND 126 GND 127 PEx16_OR(10)p 128 PEx16_OR(10)p 129 PEx16_OR(10)p 120 GND 121 PEx16_OR(10)p 121 PEx16_OR(10)p 122 PEx16_OR(10)p 123 PEx16_OR(10)p 124 PEx16_OR(10)p 125 GND 126 GND 127 PEx16_OR(10)p 128 PEx16_OR(10)p 129 PEx16_OR(10)p 120 GND 121 PEx16_OR(10)p 121 PEx16_OR(10)p 122 PEx16_OR(10)p 123 PEx16_OR(10)p 124 PEx16_OR(10)p 125 GND 126 GND 127 PEx16_OR(10)p 128 PEx16_OR(10)p 129 PEx16_OR(10)p 120 GND 121 PEx16_OR(10)p 120 GND 121 PEx16_OR(10)p 120 GND 120	71	PEx16_0T(10)n		PEx16_0T(2)n	72	5 5	72	PEx16_0T(2)n		PEx16_0T(10)n	71
87 PExt6_OT(13)p 88 PExt6_OT(13)p 91 GND 92 PExt6_OT(14)p 93 PExt6_OT(14)p 95 PExt6_OT(14)p 96 PExt6_OT(6)p 97 GND GND 98 PExt6_OT(6)p 98 GND 99 PExt6_OT(14)p 99 PExt6_OT(5)p 101 PExt6_OT(5)p 103 GND GND 99 PExt6_OT(5)p 103 GND GND 104 GND 105 STK2/SDVO_DAT 106 STK2/SDVO_DAT 107 GND 108 PExt6_OR(8)p 119 PExt6_OR(8)p 111 PExt6_OR(8)p 111 PExt6_OR(8)p 112 PExt6_OR(8)p 113 GND GND 114 GND 115 PExt6_OR(9)p 117 PExt6_OR(9)p 118 GND 119 GND 119 GND 110 PExt6_OR(9)p 117 PExt6_OR(9)p 118 GND 119 GND 120 PExt6_OR(10)p 121 PExt6_OR(10)p 122 PExt6_OR(10)p 123 PExt6_OR(10)p 124 PExt6_OR(10)p 125 GND 126 GND 127 PExt6_OR(10)p 128 PExt6_OR(10)p 129 PExt6_OR(10)p 129 PExt6_OR(10)p 120 GND 121 PExt6_OR(10)p 121 PExt6_OR(10)p 122 PExt6_OR(10)p 123 PExt6_OR(10)p 124 PExt6_OR(10)p 125 GND 126 GND 127 PExt6_OR(10)p 129 PExt6_OR(10)p 120 GND 121 PExt6_OR(10)p 121 PExt6_OR(10)p 122 PExt6_OR(10)p 123 PExt6_OR(10)p 124 PExt6_OR(10)p 125 GND 126 GND 127 PExt6_OR(10)p 129 PExt6_OR(10)p 120 GND 121 PExt6_OR(10)p 121 PExt6_OR(10)p 122 PExt6_OR(10)p 123 PExt6_OR(10)p 124 PExt6_OR(10)p 125 GND 126 GND 127 PExt6_OR(10)p 128 PExt6_OR(10)p 129 PExt6_OR(10)p 120 GND 121 PExt6_OR(10)p 121 PExt6_OR(10)p 122 PExt6_OR(10)p 123 PExt6_OR(10)p 124 PExt6_OR(10)p 125 GND 126 GND 127 PExt6_OR(10)p 128 PExt6_OR(10)p 129 PExt6_OR(10)p 120 GND 121 PExt6_OR(10)p 121 PExt6_OR(10)p 122 PExt6_OR(10)p 123 PExt6_OR(10)p 124 PExt6_OR(10)p 125 FExt6_OR(10)p 126 GND 127 PExt6_OR(10)p 128 PExt6_OR(10)p 129 PExt6_OR(10)p 120 GND 121 PExt6_OR(10)p 120 GND 121 PExt6_OR(10)p 121 PExt6_OR(10)p 122 PExt6_OR(10)p 123 PExt6_OR(10)p 124 PExt6_OR(10)p 125 PExt6_OR(10)p 126 PExt6_OR(10)p 127 PExt6_OR(10)p 128 PExt6_OR(10)p 129 PExt6_OR(10)p 120 GND	_					o o					73
87 PExt6_OT(13)p 88 PExt6_OT(13)p 91 GND 92 PExt6_OT(14)p 93 PExt6_OT(14)p 95 PExt6_OT(14)p 96 PExt6_OT(6)p 97 GND GND 98 PExt6_OT(6)p 98 GND 99 PExt6_OT(14)p 99 PExt6_OT(5)p 101 PExt6_OT(5)p 103 GND GND 99 PExt6_OT(5)p 103 GND GND 104 GND 105 STK2/SDVO_DAT 106 STK2/SDVO_DAT 107 GND 108 PExt6_OR(8)p 119 PExt6_OR(8)p 111 PExt6_OR(8)p 111 PExt6_OR(8)p 112 PExt6_OR(8)p 113 GND GND 114 GND 115 PExt6_OR(8)p 117 PExt6_OR(8)p 118 GND 119 GND 119 GND 110 PExt6_OR(1)p 117 PExt6_OR(8)p 118 GND 119 GND 120 PExt6_OR(1)p 121 PExt6_OR(8)p 121 PExt6_OR(8)p 122 PExt6_OR(1)p 123 PExt6_OR(1)p 124 PExt6_OR(8)p 125 GND 126 GND 127 PExt6_OR(1)p 128 PExt6_OR(1)p 129 PExt6_OR(1)p 129 PExt6_OR(1)p 129 PExt6_OR(8)p 120 GND 121 PExt6_OR(1)p 121 PExt6_OR(1)p 122 PExt6_OR(1)p 123 PExt6_OR(1)p 124 PExt6_OR(8)p 125 GND 126 GND 127 PExt6_OR(8)p 128 PExt6_OR(8)p 129 PExt6_OR(8)p 120 GND 121 PExt6_OR(1)p 121 PExt6_OR(1)p 122 PExt6_OR(8)p 123 PExt6_OR(1)p 124 PExt6_OR(8)p 125 GND 126 GND 127 PExt6_OR(8)p 128 PExt6_OR(8)p 129 PExt6_OR(8)p 120 GND 121 PExt6_OR(1)p 121 PExt6_OR(1)p 122 PExt6_OR(1)p 123 PExt6_OR(1)p 124 PExt6_OR(8)p 125 GND 126 GND 127 PExt6_OR(8)p 128 PExt6_OR(8)p 129 PExt6_OR(8)p 120 GND 121 PExt6_OR(1)p 121 PExt6_OR(1)p 122 PExt6_OR(1)p 123 PExt6_OR(1)p 124 PExt6_OR(8)p 125 FExt6_OR(8)p 126 GND 127 PExt6_OR(1)p 128 PExt6_OR(8)p 129 PExt6_OR(1)p 120 GND 121 PExt6_OR(1)p 121 PExt6_OR(1)p 122 PExt6_OR(8)p 123 PExt6_OR(1)p 124 PExt6_OR(8)p 125 PExt6_OR(8)p 126 GND 127 PExt6_OR(1)p 128 PExt6_OR(8)p 129 PExt6_OR(8)p 120 GND 120 GND 121 PExt6_OR(8)p 120 GND 121 PExt6_OR(8)p 121 PExt6_OR(8)p 122 PExt6_OR(8)p 123 PExt6_OR(8)p 124 PExt6_OR(8)p 125 PExt6_OR(8)p 126 GND 127 PExt6_OR(8)p 128 PExt6_OR(8)p 129 PExt6_OR(8)p 120 GND 120 GN						2 2	-				
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87		PEx16_0T(11)n	ĕ	PEx16_0T(3)n			78		<u>ē</u>	PEx16_0T(11)n	77
87	79	GND	2 \	GND	80		80	GND	2 \	GND	79
B	81	PEx16_0T(12)p	+	PEx16 0T(4)p	82	<u> </u>	82	PEx16_0T(4)p	+	PEx16 0T(12)p	81
B	83	PEx16_0T(12)n			84	2 2	84	PEx16_0T(4)n		PFx16_0T(12)n	83
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91 GND 93 PEX16_0T(14)p 95 PEX16_0T(14)p 96 PEX16_0T(15)p 97 GND 99 PEX16_0T(15)p 101 PEX16_0T(15)p 103 GND GND 104 GND 105 STK2 / SDVO_DAT 107 GND 108 GND 109 PEX16_0R(8)p 111 PEX16_0R(8)p 111 PEX16_0R(8)p 111 PEX16_0R(8)p 111 PEX16_0R(8)p 111 PEX16_0R(8)p 111 PEX16_0R(9)p 111 PEX16_0R(9)p 112 PEX16_0R(10)p 113 GND 114 PEX16_0R(9)p 117 PEX16_0R(9)p 118 PEX16_0R(10)p 119 GND 120 GND 121 PEX16_0R(10)p 121 PEX16_0R(10)p 122 PEX16_0R(10)p 123 PEX16_0R(10)p 124 PEX16_0R(10)p 125 GND 126 GND 127 PEX16_0R(10)p 128 PEX16_0R(10)p 129 PEX16_0R(10)p 121 PEX16_0R(10)p 122 PEX16_0R(10)p 123 PEX16_0R(10)p 124 PEX16_0R(10)p 125 GND 137 GND 131 GND 138 PEX16_0R(10)p 139 PEX16_0R(10)p 120 GND 130 FEX16_0R(10)p 131 GND 131 GND 132 PEX16_0R(10)p 133 PEX16_0R(10)p 134 GND 135 PEX16_0R(10)p 136 FEX16_0R(10)p 137 GND 138 PEX16_0R(10)p 149 PEX16_0R(2)p 140 PEX16_0R(10)p 150 PEX16_0R(10					_						87
PEX16_0T(14)p PEX16_0T(15)p PEX16_0T(15)											89
PEX16_0T(14)n PEX16_0T(15)n PEX16_0T(15)n PEX16_0T(7)n 102 PEX16_0T(7)n 102 PEX16_0T(7)n 102 PEX16_0T(7)n 102 PEX16_0T(7)n 102 PEX16_0T(7)n 102 PEX16_0T(7)n 104 GND PEX16_0T(15)n PEX	91	GND		GND	92		92	GND		GND	91
97 GND 98 PEX16_OT(15)p PEX16_OT(7)p 100 101 PEX16_OT(15)p 100 PEX16_OT(7)p 100 103 GND 104 105 STK2/SDVO_DAT 107 GND 108 107 GND 108 PEX16_OR(8)p 110 PEX16_OR(8)p 117 PEX16_OR(8)p PEX16_OR(9)p PEX16_OR(9)p 118 GND GND 119 GND 110 119 GND PEX16_OR(9)p PEX16_OR(9)p PEX16_OR(1)p PEX16_OR(9)p 117 PEX16_OR(9)p PEX16_OR(1)p PEX16_OR(1)p PEX16_OR(9)p 118 GND PEX16_OR(1)p PEX16_OR(1)p PEX16_OR(1)p PEX16_OR(9)p 121 PEX16_OR(10)p PEX16_OR(1)p PEX16_OR(2)p 122 PEX16_OR(1)p 122 PEX16_OR(11)p PEX16_OR(2)p 124 GND 126 GND GND 126 127 PEX16_OR(11)p PEX16_OR(2)p 124 GND 126 PEX16_OR(3)p 133 GND GND 132 129 PEX16_OR(12)p PEX16_OR(3)p 134 PEX16_OR(3)p PEX16_OR(1)p PEX16_OR(93	PEx16_0T(14)p		PEx16_0T(6)p	94		94	PEx16_0T(6)p		PEx16_0T(14)p	93
97 GND 98 PEX16_OT(15)p PEX16_OT(7)p 100	95	PEx16_0T(14)n		PEx16_0T(6)n	96		96	PEx16_0T(6)n		PEx16_0T(14)n	95
PEX16_OT(15)p	97				98		98				97
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105 STK2 / SDVO_DAT 106 SDVO_CLK 106 GND 108 109 PEx16_0R(8)p 110 PEx16_0R(8)p 110 PEx16_0R(9)p 110 PEx16_0R(9)p 110 PEx16_0R(9)p 110 PEx16_0R(9)p 110 PEx16_0R(9)p 1110 PEx16_0R(1)p 116 PEx16_0R(1)p 116 PEx16_0R(1)p 119 GND 120 PEx16_0R(10)p 12					_		_				_
STK2 / SDVO_DAT 106 SDVO_CLK 106 SDVO_CLK 107 GND 108 GND 110 PEx16_DR(8)p 1111 PEx16_DR(8)p 1111 PEx16_DR(8)p 1112 PEx16_DR(9)p 112 GND 112 GND 114 GND PEx16_DR(10)p 115 PEx16_DR(10)p 120 PEx16_DR(10)p 121 PEx16_DR(10)p PEx16_DR(10)p 122 PEx16_DR(10)p 123 PEx16_DR(10)p 126 GND 126 GND 127 PEx16_DR(11)p 128 PEx16_DR(11)p 129 PEx16_DR(11)p 126 GND 127 PEx16_DR(11)p 128 PEx16_DR(11)p 129 PEx16_DR(11)p 133 GND 133 PEx16_DR(12)p 134 PEx16_DR(12)p 134 PEx16_DR(12)p 135 PEx16_DR(12)p 136 PEx16_DR(13)p 137 GND 138 PEx16_DR(13)p 141 PEx16_DR(13)p 141 PEx16_DR(13)p 142 PEx16_DR(13)p 143 GND 144 PEx16_DR(13)p 144 GND 144 GND PEx16_DR(13)p 146 PEx16_DR(14)p 147 PEx16_DR(14)p 148 GND 148 GND 150 G											101
107 GND GND 108 Fext6_0R(8)p 110 Fext6_0R(8)p 110 Fext6_0R(8)p 1110 Fext6_0R(8)p 1111 Fext6_0R(8)p 1111 Fext6_0R(8)p 1112 Fext6_0R(9)p 1114 GND 1114 GND GND 1114 GND Fext6_0R(1)p Fext6_0R(1)p Fext6_0R(1)p 118 GND 120 Fext6_0R(1)p 123 Fext6_0R(1)p Fext6_0R(1)p 126 GND 126 GND 126 GND 126 GND 127 Fext6_0R(1)p Fext6_0R(1)p 128 Fext6_0R(1)p 129 Fext6_0R(1)p 120 Fext6_0R(2)p 122 Fext6_0R(2)p 123 GND 132 GND 132 GND 132 GND 132 GND 132 GND 132 GND 133 Fext6_0R(13)p Fext6_0R(4)p Fext6_0R(4)p Fext6_0R(3)p 134 Fext6_0R(3)p 135 Fext6_0R(13)p 144 GND GND 150 Fext6_0R(5)p 146 F	103	GND		GND	104		104	GND		GND	103
TOT GND GND TOT GND TOT											
The first content of the fir	105	STK2 / SDV O_DAT	_	SDVO_CLK		_		SDVO_CLK		STK2 / SDV O_DAT	105
The content of the	107	GND		GND	108		108	GND		GND	107
The content of the	109	PEx16_0R(8)p		PEx16_0R(0)p	110		110	PEx16_0R(0)p	l	PEx16_0R(8)p	109
113 GND	111	PEx16_0R(8)n		PEx16_0R(0)n	112		112	PEx16_0R(0)n	l		111
Title									l		113
117 PEX16_OR(9)n 119 GND 121 PEX16_OR(10)n 122 PEX16_OR(10)n 122 PEX16_OR(10)n 123 PEX16_OR(10)n 125 GND 126 GND 127 PEX16_OR(11)n 129 PEX16_OR(11)n 129 PEX16_OR(11)n 120 GND 121 PEX16_OR(2)n 122 PEX16_OR(2)n 124 PEX16_OR(2)n 125 GND 126 GND 127 PEX16_OR(11)n 128 PEX16_OR(11)n 129 PEX16_OR(11)n 131 GND 132 FEX16_OR(12)n 133 PEX16_OR(12)n 133 PEX16_OR(12)n 135 PEX16_OR(12)n 136 PEX16_OR(4)n 137 GND 138 PEX16_OR(12)n 139 PEX16_OR(13)n 130 GND 131 GND 131 GND 132 GND 133 PEX16_OR(12)n 134 PEX16_OR(4)n 135 PEX16_OR(13)n 136 PEX16_OR(4)n 137 GND 138 FEX16_OR(13)n 139 PEX16_OR(13)n 140 PEX16_OR(13)n 141 PEX16_OR(13)n 142 GND 143 GND 144 GND 145 PEX16_OR(14)n 146 PEX16_OR(6)n 147 PEX16_OR(14)n 148 GND 150 GND 150 GND 150 GND 150 GND 150 GND 150 FEX16_OR(15)n 151 PEX16_OR(15)n 152 PEX16_OR(15)n 153 PEX16_OR(15)n 154 PEX16_OR(15)n 155 PEX16_OR(15)n 156 PEX16_OR(15)n 157 PEX16_OR(15)n 158 PEX16_OR(15)n 159 PEX16_OR(15)n 150 GND 150 FEX16_OR(15)n 150 GND 150 FEX16_OR(15)n 150 FEX1											115
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121											117
123 PEX16_OR(10)n 125 GND 127 PEX16_OR(11)p 129 PEX16_OR(11)p 131 GND 133 PEX16_OR(12)p 133 PEX16_OR(12)p 133 PEX16_OR(12)p 135 PEX16_OR(13)n 136 PEX16_OR(13)n 137 GND 138 PEX16_OR(13)n 139 PEX16_OR(13)n 139 PEX16_OR(13)n 139 GND 139 GND 139 PEX16_OR(13)n 130 GND 131 GND 131 GND 132 GND 133 PEX16_OR(13)n 134 PEX16_OR(4)p 135 PEX16_OR(13)n 136 PEX16_OR(14)n 137 GND 138 GND 139 PEX16_OR(13)n 139 PEX16_OR(13)n 130 FEX16_OR(13)n 131 GND 132 GND 133 PEX16_OR(13)n 134 PEX16_OR(13)n 135 PEX16_OR(13)n 136 PEX16_OR(5)p 140 PEX16_OR(6)p 141 PEX16_OR(13)n 141 PEX16_OR(13)n 142 FEX16_OR(13)n 143 GND 144 GND 145 PEX16_OR(14)p 146 PEX16_OR(6)p 147 PEX16_OR(14)p 148 GND 150 GND 150 FEX16_OR(15)p 151 PEX16_OR(15)p 152 PEX16_OR(15)n 154 PEX16_OR(15)n 155 PEX16_OR(15)n 156 PEX16_OR(7)n 157 PEX16_OR(15)n 157 PEX16_OR(15)n 158 PEX16_OR(15)n 159 PEX16_OR(15)n 150 PEX	119	GND		GND	120		120	GND		GND	119
125	121			PEx16_0R(2)p	122		122		l		121
125	123	PEx16_0R(10)n		PEx16_0R(2)n	124		124	PEx16_0R(2)n	l	PEx16_0R(10)n	123
127	125				126		126		l	GND	125
129 PEX16_OR(11)n 130 PEX16_OR(3)n 130 PEX16_OR(3)n 130 PEX16_OR(12)p 134 PEX16_OR(12)p 134 PEX16_OR(12)p 134 PEX16_OR(12)n 136 PEX16_OR(4)n 136 PEX16_OR(4)n 136 PEX16_OR(4)n 136 PEX16_OR(4)n 136 PEX16_OR(5)n 138 GND 138 GND 138 GND 140 PEX16_OR(13)n PEX16_OR(5)n 142 PEX16_OR(13)n 144 PEX16_OR(13)n 145 PEX16_OR(14)n 144 GND 145 PEX16_OR(14)n 146 PEX16_OR(6)p 146 PEX16_OR(6)p 146 PEX16_OR(14)n 148 PEX16_OR(6)n 148 PEX16_OR(6)n 148 PEX16_OR(5)n 149 GND 150 GND 150 GND 150 GND 150 PEX16_OR(15)n 1			l				-		l		127
135 PEX16_OR(12)p PEX16_OR(13)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(15)p PEX16_OR(15)p PEX16_OR(15)p PEX16_OR(7)p PEX16			ţ			က			ts		
135 PEX16_OR(12)p PEX16_OR(13)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(15)p PEX16_OR(15)p PEX16_OR(15)p PEX16_OR(7)p PEX16		PEX ID UK(11)n	8			춪			%		129
135 PEX16_OR(12)p PEX16_OR(13)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(15)p PEX16_OR(15)p PEX16_OR(15)p PEX16_OR(7)p PEX16	129					æ			42		131
137	129 131	GND	2	PEx16_0R(4)p	134	_	134	PEx16_0R(4)p	+	PEx16_0R(12)p	133
137	129 131	GND PEx16_0R(12)p	¥		136		136	PEx16_0R(4)n		PEx16_0R(12)n	135
139 PEx16_0R(13)p PEx16_0R(5)p 140 PEx16_0R(5)p PEx16_0R(13)p 1 141 PEx16_0R(13)n PEx16_0R(5)n 142 142 PEx16_0R(5)n PEx16_0R(13)n 1 143 GND GND 144 GND GND 1 145 PEx16_0R(14)p PEx16_0R(6)p 146 PEx16_0R(6)p PEx16_0R(14)p 1 147 PEx16_0R(14)n PEx16_0R(6)n 148 PEx16_0R(6)n PEx16_0R(14)n PEx16_0R(7)n PEx16_0R(7)n 150 GND GND GND 1 151 PEx16_0R(15)p PEx16_0R(7)p 152 152 PEx16_0R(7)p PEx16_0R(15)p PEx16_0R(7)n PEx16_0R(7)n PEx16_0R(7)n PEx16_0R(7)n PEx16_0R(15)n	129 131 133	GND PEx16_0R(12)p	¥	PEx16_0R(4)n							137
141 PEx16_0R(13)n PEx16_0R(5)n 142 PEx16_0R(5)n PEx16_0R(13)n 1 143 GND GND 144 GND GND 1 145 PEx16_0R(14)p PEx16_0R(6)p 146 146 PEx16_0R(6)p PEx16_0R(14)p 1 147 PEx16_0R(14)n PEx16_0R(6)n 148 148 PEx16_0R(6)n PEx16_0R(14)n 1 149 GND GND 150 GND GND GND 150 151 PEx16_0R(15)p PEx16_0R(7)p 152 PEx16_0R(7)p PEx16_0R(7)p PEx16_0R(7)n PEx16_0R(7)n PEx16_0R(7)n	129 131 133 135	GND PEx16_0R(12)p PEx16_0R(12)n	475		138		اتت		1		139
143 GND GND 144 GND GND 1 145 PEX16_0R(14)p PEX16_0R(6)p 146 146 PEX16_0R(6)p PEX16_0R(14)p 1 147 PEX16_0R(14)n PEX16_0R(6)n 148 148 PEX16_0R(6)n PEX16_0R(14)n 1 149 GND GND 150 GND GND GND 151 PEX16_0R(15)p PEX16_0R(7)p 152 PEX16_0R(7)p PEX16_0R(15)p PEX16_0R(7)n PEX16_0R(15)n PEX16_0R(15)n PEX16_0R(7)n PEX16_0R(15)n	129 131 133 135 137	GND PEx16_0R(12)p PEx16_0R(12)n GND	4	GND			140				- 139
145 PEx16_0R(14)p PEx16_0R(6)p 146 PEx16_0R(6)p PEx16_0R(14)p 1 147 PEx16_0R(14)n PEx16_0R(6)n 148 148 PEx16_0R(6)n PEx16_0R(14)n 1 149 GND GND 150 GND GND GND GND GND GND FEx16_0R(15)p PEx16_0R(7)p PEx16_0R(7)p PEx16_0R(15)p PEx16_0R(15)p PEx16_0R(7)p PEx16_0R(7)p PEx16_0R(7)p PEx16_0R(7)p PEx16_0R(7)p PEx16_0R(7)p PEx16_0R(15)p PEx16_0R(7)p PEx16_0R(7)p PEx16_0R(7)p PEx16_0R(7)p PEx16_0R(15)p PEx16_0R(7)p PEx	129 131 133 135 137 139	GND PEx16_0R(12)p PEx16_0R(12)n GND PEx16_0R(13)p	¥	GND PEx16_0R(5)p	140						
147 PEx16_0R(14)n PEx16_0R(6)n 148 PEx16_0R(6)n PEx16_0R(14)n 1 149 GND GND 150 GND GND 1 151 PEx16_0R(15)p PEx16_0R(7)p 152 PEx16_0R(7)p PEx16_0R(15)p PEx16_0R(15)p 1 153 PEx16_0R(15)n PEx16_0R(7)n 154 PEx16_0R(7)n PEx16_0R(15)n 1	129 131 133 135 137 139 141	GND PEx16_0R(12)p PEx16_0R(12)n GND PEx16_0R(13)p PEx16_0R(13)n	42	GND PEx16_0R(5)p PEx16_0R(5)n	140 142		142	PEx16_0R(5)n		PEx16_0R(13)n	141
149 GND GND 150 GND GND 1 151 PEx16_0R(15)p PEx16_0R(7)p 152 PEx16_0R(7)p PEx16_0R(15)p PEx16_0R(15)p 1 153 PEx16_0R(15)n PEx16_0R(7)n 154 PEx16_0R(7)n PEx16_0R(15)n 1	129 131 133 135 137 139 141 143	GND PEx16_0R(12)p PEx16_0R(12)n GND PEx16_0R(13)p PEx16_0R(13)p GND GND	ZI+	GND PEx16_0R(5)p PEx16_0R(5)n GND	140 142 144		142 144	PEx16_0R(5)n GND		PEx16_0R(13)n GND	141 143
149 GND GND 150 GND GND 1 151 PEx16_0R(15)p PEx16_0R(7)p 152 PEx16_0R(7)p PEx16_0R(15)p PEx16_0R(15)p 1 153 PEx16_0R(15)n PEx16_0R(7)n 154 PEx16_0R(7)n PEx16_0R(15)n 1	129 131 133 135 137 139 141 143	GND PEx16_0R(12)p PEx16_0R(12)n GND PEx16_0R(13)p PEx16_0R(13)p GND GND	ZI+	GND PEx16_0R(5)p PEx16_0R(5)n GND	140 142 144		142 144	PEx16_0R(5)n GND		PEx16_0R(13)n GND	141
151 PEx16_0R(15)p PEx16_0R(7)p 152 PEx16_0R(7)p PEx16_0R(15)p 1 153 PEx16_0R(15)n PEx16_0R(7)n 154 PEx16_0R(7)n PEx16_0R(15)n PEx16_0R(15)n	129 131 133 135 137 139 141 143	GND PEX16_DR(12)p PEX16_DR(12)n GND PEX16_DR(13)p PEX16_DR(13)p PEX16_DR(13)n GND PEX16_DR(14)p	Z1+	GND PEx16_0R(5)p PEx16_0R(5)n GND PEx16_0R(6)p	140 142 144 146		142 144 146	PEx16_0R(5)n GND PEx16_0R(6)p		PEx16_0R(13)n GND PEx16_0R(14)p	141 143
153 PEx16_0R(15)n PEx16_0R(7)n 154 PEx16_0R(7)n PEx16_0R(15)n 1	129 131 133 135 137 139 141 143 145	GND PEX16_DR(12)p PEX16_DR(12)n GND PEX16_DR(13)p PEX16_DR(13)n GND PEX16_DR(14)p PEX16_DR(14)p PEX16_DR(14)p	Z1+	GND PEx16_0R(5)p PEx16_0R(5)n GND PEx16_0R(6)p PEx16_0R(6)p	140 142 144 146 148		142 144 146 148	PEx16_0R(5)n GND PEx16_0R(6)p PEx16_0R(6)n		PEx16_0R(13)n GND PEx16_0R(14)p PEx16_0R(14)n	141 143 145 147
	129 131 133 135 137 139 141 143 145 147	GND PEX16_DR(12)p PEX16_DR(12)n GND PEX16_DR(13)p PEX16_DR(13)p GND GND FEX16_DR(14)p PEX16_DR(14)p GND GND	Z1+	GND PEx16_0R(5)p PEx16_0R(5)n GND PEx16_0R(6)p PEx16_0R(6)p PEx16_0R(6)n GND	140 142 144 146 148 150		142 144 146 148 150	PEx16_0R(5)n GND PEx16_0R(6)p PEx16_0R(6)n GND		PEx16_0R(13)n GND PEx16_0R(14)p PEx16_0R(14)n GND	141 143 145 147 149
155 GND	129 131 133 135 137 139 141 143 145 147 149	GND PEX16_OR(12)p PEX16_OR(12)p GND PEX16_OR(13)p PEX16_OR(13)n GND PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(14)n GND PEX16_OR(15)p	ZI+	GND PEX16_0R(5)p PEX16_0R(5)n GND PEX16_0R(6)p PEX16_0R(6)n GND PEX16_0R(7)p	140 142 144 146 148 150		142 144 146 148 150 152	PEx16_0R(5)n GND PEx16_0R(6)p PEx16_0R(6)n GND PEx16_0R(7)p		PEx16_0R(13)n GND PEx16_0R(14)p PEx16_0R(14)n GND PEx16_0R(15)p	141 143 145 147 149 151
	129 131 133 135 137 139 141 143 145 147 149 151	GND PEX16_OR(12)p PEX16_OR(12)p GND GND PEX16_OR(13)p PEX16_OR(13)n GND PEX16_OR(14)p PEX16_OR(14)p PEX16_OR(15)p FEX16_OR(15)p PEX16_OR(15)p	ZI+	GND PEX16_OR(5)p PEX16_OR(5)n GND PEX16_OR(6)p PEX16_OR(6)p GND PEX16_OR(7)p PEX16_OR(7)p PEX16_OR(7)p	140 142 144 146 148 150 152		142 144 146 148 150 152	PEx16_0R(5)n GND PEx16_0R(6)p PEx16_0R(6)n GND PEx16_0R(7)p PEx16_0R(7)p		PEx16_0R(13)n GND PEx16_0R(14)p PEx16_0R(14)n GND PEx16_0R(15)p PEx16_0R(15)p	141 143 145 147 149

Table 2-4 Connector A, Type 2 Pin Assignments

	Top View Si	gna	l Assignment					Bottom View	Sian	al Assignment	
1	USB_OC#	9	PE_RST#	2	_		2	PE_RST#	J.g	USB_OC#	1
3	3.3V		3.3V	4			4	3.3V		3.3V	3
5				6			6				5
	USB_1p		USB_0p					USB_0p		USB_1p	_
7	USB_1n		USB_0n	8			8	USB_0n		USB_1n	7
9	GND		GND	10			10	GND		GND	9
11	PEx1_1Tp		PEx1_0Tp	12			12	PEx1_0Tp		PEx1_1Tp	11
13	PEx1_1Tn	1	PEx1_0Tn	14			14	PEx1_0Tn		PEx1_1Tn	13
15	GND	1	GND	16			16	GND	1	GND	15
17	PEx1_2Tp		PEx1_3Tp	18			18	PEx1_3Tp		PEx1_2Tp	17
_											_
19	PEx1_2Tn		PEx1_3Tn	20			20	PEx1_3Tn		PEx1_2Tn	19
21	GND		GND	22			22	GND		GND	21
23	PEx1_1Rp		PEx1_0Rp	24		_	24	PEx1_0Rp	۱	PEx1_1Rp	23
25	PEx1_1Rn	1 #	PEx1_0Rn	26		<u> </u>	26	PEx1_0Rn	l ¥	PEx1_1Rn	25
27	GND	+5 Volts	GND	28		Bank	28	GND	45 Volts	GND	27
29		¥.		30		ď	30		¥.		29
	PEx1_2Rp		PEx1_3Rp					PEx1_3Rp		PEx1_2Rp	
31	PEx1_2Rn		PEx1_3Rn	32			32	PEx1_3Rn		PEx1_2Rn	31
33	GND		GND	34			34	GND		GND	33
35	PEx1_1Clkp		PEx1_0Clkp	36			36	PEx1_0Clkp		PEx1_1Clkp	35
37	PEx1_1Clkn	1	PEx1_0Clkn	38			38	PEx1_0Clkn		PEx1_1Clkn	37
39	+5V_SB		+5V SB	40			40	+5V SB		+5V SB	39
_	_										_
41	PEx1_2Clkp		PEx1_3Clkp	42			42	PEx1_3Clkp		PEx1_2Clkp	41
43	PEx1_2Clkn		PEx1_3Clkn	44			44	PEx1_3Clkn		PEx1_2Clkn	43
45	DIR	1	PWRGOOD	46			46	PWRGOOD		DIR	45
47	SMB_DAT	1	PEx_x4_Clkp	48			48	PEx_x4_Clkp	i	SMB_DAT	47
49	SMB_CLK	i	PEx_x4_Clkn	50			50	PEx_x4_Clkn	ı	SMB_CLK	49
	_	l							l		_
51	SMB_ALERT	l	PSON#	52			52	PSON#	l	SMB_ALERT	51
_					_		_				
53	STK0 / WAKE#		STK1 / PEG_ENA#	54			54	STK1 / PEG_ENA#		STK0 / WAKE#	53
55	GND	I	GND	56			56	GND	Ī	GND	55
57	PEx4_1T(0)p		PEx4_0T(0)p	58			58	PEx4_0T(0)p		PEx4_1T(0)p	57
_											
59	PEx4_1T(0)n		PEx4_0T(0)n	60			60	PEx4_0T(0)n		PEx4_1T(0)n	59
61	GND		GND	62			62	GND		GND	61
63	PEx4_1T(1)p		PEx4_0T(1)p	64			64	PEx4_0T(1)p		PEx4_1T(1)p	63
65	PEx4_1T(1)n	1	PEx4_0T(1)n	66			66	PEx4_0T(1)n		PEx4_1T(1)n	65
67	GND		GND	68			68	GND		GND	67
69	PEx4_1T(2)p		PEx4_0T(2)p	70			70	PEx4_0T(2)p		PEx4_1T(2)p	69
					σ						_
71	PEx4_1T(2)n		PEx4_0T(2)n	72	board		72 74	PEx4_0T(2)n		PEx4_1T(2)n	71
73	GND		GND	74	8		8 74	GND		GND	73
75	PEx4_1T(3)p		PEx4_0T(3)p	76	φ		76	PEx4_0T(3)p		PEx4_1T(3)p	75
77	PEx4_1T(3)n	\$	PEx4_0T(3)n	78		2	78	PEx4_0T(3)n	\$	PEx4_1T(3)n	77
79	GND	+5 Volts		80	풑	Bank 2	E		+5 Volts		79
		¥.	GND	_	center	m	78 80 82	GND	\$	GND	
81	SATA_T1p		SATA_T0p	82	Ď	-	82	SATA_T0p		SATA_T1p	81
83	SATA_T1n		SATA_T0n	84	oward		84 86	SATA_T0n		SATA_T1n	83
85	GND	1	GND	86	8		86	GND		GND	85
87	SSTX1p		SSTX0p	88	F		88	SSTX0p		SSTX1p	87
				90			-				
89	SSTX1n		SSTX0n				90	SSTX0n		SSTX1n	89
91	GND		GND	92			92	GND		GND	91
93	Reserved		Reserved	94			94	Reserved		Reserved	93
95	Reserved	1	Reserved	96			96	Reserved		Reserved	95
97	GND	1	GND	98			98	GND		GND	97
99	SATA DET#1		SATA_DET#0	100			100	SATA_DET#0		SATA_DET#1	99
_							-				
101	SATA_PWREN#1		SATA_PWREN#0	102			102	SATA_PWREN#0		SATA_PWREN#1	101
103	GND		GND	104	_		104	GND		GND	103
105	STK2 / SDVO_DAT		LPC_CLK	106	_		106	LPC_CLK		STK2 / SDVO_DAT	105
107	GND	1	GND	108			108	GND	1	GND	107
	PEx4_1R(0)p		PEx4_0R(0)p	-			_			PEx4_1R(0)p	_
109		l		110			110	PEx4_0R(0)p	l		109
111	PEx4_1R(0)n		PEx4_0R(0)n	112			112	PEx4_0R(0)n		PEx4_1R(0)n	111
113	GND		GND	114			114	GND	l	GND	113
	PEx4_1R(1)p		PEx4_0R(1)p	116			116	PEx4_0R(1)p		PEx4_1R(1)p	115
115	FEX4_1F(1)P		PEx4_0R(1)n	118						PEx4_1R(1)n	117
_							11181	PEx4_0R(1)n		GND	119
117	PEx4_1R(1)n		GND	120			118	PEx4_0R(1)n	1	GND	113
117 119	PEx4_1R(1)n GND		GND	120			120	GND	1	DE-1 4D(0)-	404
117 119 121	PEx4_1R(1)n GND PEx4_1R(2)p		PEx4_0R(2)p	122			120 122	GND PEx4_0R(2)p		PEx4_1R(2)p	121
117 119 121 123	PEx4_1R(1)n GND PEx4_1R(2)p PEx4_1R(2)n			122 124			120 122 124	GND		PEx4_1R(2)p PEx4_1R(2)n	123
117 119 121	PEx4_1R(1)n GND PEx4_1R(2)p PEx4_1R(2)n		PEx4_0R(2)p PEx4_0R(2)n GND	122			120 122	GND PEx4_0R(2)p			
117 119 121 123	PEx4_1R(1)n GND PEx4_1R(2)p PEx4_1R(2)n GND		PEx4_0R(2)p PEx4_0R(2)n GND	122 124			120 122 124	GND PEx4_0R(2)p PEx4_0R(2)n GND		PEx4_1R(2)n GND	123
117 119 121 123 125 127	PEX4_1R(1)n GND PEX4_1R(2)p PEX4_1R(2)n GND PEX4_1R(3)p	ofts	PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p	122 124 126 128		3	120 122 124 126 128	GND PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p	ıts	PEx4_1R(2)n GND PEx4_1R(3)p	123 125 127
117 119 121 123 125 127 129	PEX4_1R(1)n GND PEX4_1R(2)p PEX4_1R(2)n GND PEX4_1R(3)p PEX4_1R(3)p	Volts	PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p PEx4_0R(3)n	122 124 126 128 130		ank 3	120 122 124 126 128 130	GND PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p PEx4_0R(3)n	Volts	PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n	123 125 127 129
117 119 121 123 125 127 129 131	PEx4_1R(1)n GND PEx4_1R(2)p PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)p PEx4_1R(3)n GND	12 Volts	PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p PEx4_0R(3)n GND GND	122 124 126 128 130 132		Bank 3	120 122 124 126 128 130	GND PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p PEx4_0R(3)n GND GND	12 Volts	PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND	123 125 127 129 131
117 119 121 123 125 127 129 131	PEx4_1R(1)n GND PEx4_1R(2)p PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND	+12 Volts	PEX4_0R(2)p PEX4_0R(2)n GND PEX4_0R(3)p PEX4_0R(3)n GND SATA_R0p	122 124 126 128 130 132		Bank 3	120 122 124 126 128 130	GND PEX4_0R(2)p PEX4_0R(2)n GND PEX4_0R(3)p PEX4_0R(3)n GND GND	+12 Volts	PEX4_1R(2)n GND PEX4_1R(3)p PEX4_1R(3)n GND SATA_R1p	123 125 127 129 131 133
117 119 121 123 125 127 129 131	PEx4_1R(1)n GND PEx4_1R(2)p PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)p PEx4_1R(3)n GND	+12 Volts	PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p PEx4_0R(3)n GND GND	122 124 126 128 130 132		Bank 3	120 122 124 126 128 130	GND PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p PEx4_0R(3)n GND GND	+12 Volts	PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND	123 125 127 129 131
117 119 121 123 125 127 129 131 133	PEx4_1R(1)n GND PEx4_1R(2)p PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n	+12 Volts	PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p PEx4_0R(3)n GND SATA_R0p SATA_R0n	122 124 126 128 130 132 134 136		Bank 3	120 122 124 126 128 130 132 134	GND PEX4_DR(2)p PEX4_DR(2)n GND PEX4_DR(3)p PEX4_DR(3)n GND SATA_R0p SATA_R0n	+12 Volts	PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n	123 125 127 129 131 133 135
117 119 121 123 125 127 129 131 133 135	PEx4_1R(1)n GND PEx4_1R(2)p PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n GND	+12 Volts	PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p PEx4_0R(3)n GND SATA_R0p SATA_R0n GND	122 124 126 128 130 132 134 136		Bank 3	120 122 124 126 128 130 132 134 136	GND PEX4_DR(2)p PEX4_DR(2)n GND PEX4_DR(3)p PEX4_DR(3)n GND SATA_R0p SATA_R0n GND	+12 Volts	PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n GND	123 125 127 129 131 133 135
117 119 121 123 125 127 129 131 133 135 137	PEx4_1R(1)n GND PEx4_1R(2)p PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n GND SSRX1p	+12 Volts	PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p PEx4_0R(3)n GND SATA_R0p SATA_R0n GND SSRX0p	122 124 126 128 130 132 134 136 138		Bank 3	120 122 124 126 128 130 132 134 136 138	GND PEX4_DR(2)p PEX4_DR(2)n GND PEX4_DR(3)p PEX4_DR(3)n GND SATA_R0p SATA_R0n GND SSRX0p	+12 Volts	PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n GND SSRX1p	123 125 127 129 131 133 135 137
117 119 121 123 125 127 129 131 133 135 137	PEx4_1R(1)n GND PEx4_1R(2)p PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n GND SSRX1p SSRX1n	+12 Volts	PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p PEx4_0R(3)n GND SATA_R0p SATA_R0n GND SSRX0p SSRX0p	122 124 126 128 130 132 134 136 138 140		Bank 3	120 122 124 126 128 130 132 134 136 138 140	GND PEx4_DR(2)p PEx4_OR(2)n GND PEx4_OR(3)p PEx4_OR(3)n GND SATA_R0p SATA_R0n GND SSRX0p SSRX0p	+12 Volts	PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n GND	123 125 127 129 131 133 135 137 139
117 119 121 123 125 127 129 131 133 135 137	PEx4_1R(1)n GND PEx4_1R(2)p PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n GND SSRX1p SSRX1n	+12 Volts	PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p PEx4_0R(3)n GND SATA_R0p SATA_R0n GND SSRX0p	122 124 126 128 130 132 134 136 138		Bank 3	120 122 124 126 128 130 132 134 136 138	GND PEX4_DR(2)p PEX4_DR(2)n GND PEX4_DR(3)p PEX4_DR(3)n GND SATA_R0p SATA_R0n GND SSRX0p	+12 Volts	PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n GND SSRX1p	123 125 127 129 131 133 135 137
117 119 121 123 125 127 129 131 133 135 137 139 141	PEx4_1R(1)n GND PEx4_1R(2)p PEx4_1R(2)p PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n GND SSRX1p SSRX1p SSRX1n GND	+12 Volts	PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p PEx4_0R(3)n GND SATA_R0p SATA_R0n GND SSRX0p SSRX0n GND	122 124 126 128 130 132 134 136 138 140 142		Bank 3	120 122 124 126 128 130 132 134 136 138 140 142	GND PEX4_DR(2)p PEX4_DR(2)n GND PEX4_DR(3)p PEX4_DR(3)n GND SATA_R0p SATA_R0n GND SSRX0p SSRX0n GND	+12 Volts	PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n GND SSRX1p SSRX1n GND	123 125 127 129 131 133 135 137 139 141
117 119 121 123 125 127 129 131 133 135 137 139 141	PEx4_1R(1)n GND PEx4_1R(2)p PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n GND SSRX1p SSRX1p SSRX1n GND LPC_AD0	+12 Volts	PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p PEx4_0R(3)n GND SATA_R0p SATA_R0n GND SSRX0p SSRX0p SSRXVn GND LPC_DRQ#	122 124 126 128 130 132 134 136 138 140 142 144		Bank 3	120 122 124 126 128 130 132 134 136 138 140 142 144	GND PEX4_DR(2)p PEX4_DR(2)n GND PEX4_DR(3)p PEX4_DR(3)n GND SATA_ROp SATA_ROn GND SSRXOp SSRXOp SSRXOp SRXOp GND LPC_DRQ#	+12 Volts	PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n GND SSRX1p SSRX1p SSRX1n GND LPC_AD0	123 125 127 129 131 133 135 137 139 141 143
117 119 121 123 125 127 129 131 133 135 137 139 141 143 145	PEx4_1R(1)n GND PEx4_1R(2)p PEx4_1R(2)p PEx4_1R(3)p PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n GND SSRX1p SSRX1n GND LPC_AD0 LPC_AD1	+12 Volts	PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)n GND SATA_R0p SATA_R0p SSRX0p SSRX0p SSRX0n GND LPC_DR0# LPC_SERIRQ#	122 124 126 128 130 132 134 136 138 140 142 144 146		Bank 3	120 122 124 126 128 130 132 134 136 138 140 142 144 146 148	GND PEX4_DR(2)p PEX4_DR(2)n GND PEX4_OR(3)p PEX4_DR(3)n GND SATA_ROD SATA_ROD SATA_ROD GND SSRXOD GND LPC_DRO# LPC_SERIRO#	+12 Volts	PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n GND SSRX1p SSRX1p SSRX1n GND LPC_AD0 LPC_AD1	123 125 127 129 131 133 135 137 139 141 143 145
117 119 121 123 125 127 129 131 133 135 137 139 141 143 145 147	PEx4_1R(1)n GND PEx4_1R(2)p PEx4_1R(2)n GND PEx4_1R(3)n PEx4_1R(3)n GND SATA_R1n GND SATA_R1n GND SSRX1p SSRX1n GND LPC_AD0 LPC_AD1 GND	+12 Volts	PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p PEx4_0R(3)n GND SATA_R0p SATA_R0p SATA_R0n GND SSRX0p SSRX0n GND LPC_DRQ# LPC_SERIRQ# GND	122 124 126 128 130 132 134 136 138 140 142 144 146 148		Bank 3	120 122 124 126 128 130 132 134 136 138 140 142 144 146 148	GND PEX4_DR(2)p PEX4_DR(2)n GND PEX4_DR(3)p PEX4_DR(3)n GND SATA_R0p SATA_R0p SATA_R0n GND SSRX0p SSRX0n GND LPC_DRQ# LPC_DRQ# LPC_SER!RQ# GND	+12 Volts	PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1p SATA_R1n GND SSRX1p SSRX1n GND LPC_AD0 LPC_AD1 GND	123 125 127 129 131 133 135 137 139 141 143 145 147
1177 1199 121 123 125 127 129 131 133 135 137 139 141 143 145 147	PEx4_1R(1)n GND PEx4_1R(2)p PEx4_1R(2)p PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n GND SSRX1p SSRX1n GND LPC_AD0 LPC_AD1 GND LPC_AD2	+12 Volts	PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p PEx4_0R(3)p PEx4_0R(3)n GND SATA_R0p SATA_R0p SATA_R0n GND SSRX0p SSRX0n GND LPC_DRO# LPC_SERRQ# GND LPC_FRAME#	122 124 126 128 130 132 134 136 138 140 142 144 146 148 150 152		Bank 3	120 122 124 126 128 130 132 134 136 138 140 142 144 146 148 150	GND PEX4_DR(2)p PEX4_DR(2)n GND PEX4_DR(3)p PEX4_DR(3)n GND SATA_R0p SATA_R0n GND SSRX0p SSRX0n GND LPC_DRO# LPC_SERIRO# GND LPC_FRAME#	+12 Volts	PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n GND SSRX1n GND LPC_AD0 LPC_AD1 GND LPC_AD2	123 125 127 129 131 133 135 137 141 143 145 147 149
1177 1199 121 123 125 127 129 131 133 135 137 139 141 143 145 147	PEx4_1R(1)n GND PEx4_1R(2)p PEx4_1R(2)n GND PEx4_1R(3)n PEx4_1R(3)n GND SATA_R1n GND SATA_R1n GND SSRX1p SSRX1n GND LPC_AD0 LPC_AD1 GND	+12 Volts	PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p PEx4_0R(3)n GND SATA_R0p SATA_R0p SATA_R0n GND SSRX0p SSRX0n GND LPC_DRQ# LPC_SERIRQ# GND	122 124 126 128 130 132 134 136 138 140 142 144 146 148		Bank 3	120 122 124 126 128 130 132 134 136 138 140 142 144 146 148	GND PEX4_DR(2)p PEX4_DR(2)n GND PEX4_DR(3)p PEX4_DR(3)n GND SATA_R0p SATA_R0p SATA_R0n GND SSRX0p SSRX0n GND LPC_DRQ# LPC_DRQ# LPC_SER!RQ# GND	+12 Volts	PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1p SATA_R1n GND SSRX1p SSRX1n GND LPC_AD0 LPC_AD1 GND	123 125 127 129 131 133 135 137 139 141 143 145 147
117 119 121 123 125 127 129 131 133 135 137 139 141 143 145 147	PEx4_1R(1)n GND PEx4_1R(2)p PEx4_1R(2)p PEx4_1R(3)p PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n GND SSRX1p SSRX1n GND LPC_AD0 LPC_AD1 LPC_AD2 LPC_AD2 LPC_AD3	+12 Volts	PEx4_0R(2)p PEx4_0R(2)n GND PEx4_0R(3)p PEx4_0R(3)p PEx4_0R(3)n GND SATA_R0p SATA_R0p SATA_R0n GND SSRX0p SSRX0n GND LPC_DRO# LPC_SERRQ# GND LPC_FRAME#	122 124 126 128 130 132 134 136 138 140 142 144 146 148 150 152		Bank 3	120 122 124 126 128 130 132 134 136 138 140 142 144 146 148	GND PEX4_DR(2)p PEX4_DR(2)n GND PEX4_DR(3)p PEX4_DR(3)n GND SATA_R0p SATA_R0n GND SSRX0p SSRX0n GND LPC_DRO# LPC_SERIRO# GND LPC_FRAME#	+12 Volts	PEx4_1R(2)n GND PEx4_1R(3)p PEx4_1R(3)n GND SATA_R1p SATA_R1n GND SSRX1n GND LPC_AD0 LPC_AD1 GND LPC_AD2	123 125 127 129 131 133 135 137 141 143 145 147 149

Table 2-5 Connector A, OneBank Pin Assignments

	Top View Si	gna	l Assignment				Bottom View Signal Assignment					1	
1	USB_OC#		PE_RST#	2	1			2	PE_RST#		USB_OC#	1	1
3	3.3V		3.3V	4	1			4	3.3V		3.3V	3	1
5	USB_1p		USB_0p	6				6	USB_0p		USB_1p	5	1
7	USB_1n		USB_0n	8				8	USB_0n		USB_1n	7	1
9	GND		GND	10				10	GND		GND	9	1
11	PEx1_1Tp		PEx1_0Tp	12				12	PEx1_0Tp		PEx1_1Tp	11	1
13	PEx1_1Tn		PEx1_0Tn	14				14	PEx1_0Tn		PEx1_1Tn	13	1
15	GND		GND	16				16	GND		GND	15	1
17	PEx1_2Tp		PEx1_3Tp	18				18	PEx1_3Tp		PEx1_2Tp	17	1
19	PEx1_2Tn		PEx1_3Tn	20	p		p	20	PEx1_3Tn		PEx1_2Tn	19	٦.
21	GND		GND	22	ğ		board	22	GND		GND	21	1
23	PEx1_1Rp		PEx1_0Rp	24	ē	_	of b	24	PEx1_0Rp	۱.,	PEx1_1Rp	23	٦.
25	PEx1_1Rn	+5 Volts	PEx1_0Rn	26	0	¥	-	26	PEx1_0Rn	+5 Volts	PEx1_1Rn	25	
27	GND	5 V	GND	28	Sente	Bank	center	28	GND	2 <	GND	27	
29	PEx1_2Rp	+	PEx1_3Rp	30	8		ē	30	PEx1_3Rp	I *	PEx1_2Rp	29	
31	PEx1_2Rn		PEx1_3Rn	32	ē		ē	32	PEx1_3Rn		PEx1_2Rn	31]
33	GND		GND	34	wa		Towa	34	GND		GND	33]
35	PEx1_1Clkp		PEx1_0Clkp	36	2		2	36	PEx1_0Clkp		PEx1_1Clkp	35	٦
37	PEx1_1Clkn		PEx1_0Clkn	38	1			38	PEx1_0Clkn		PEx1_1Clkn	37	1
39	+5V_SB		+5V_SB	40	1			40	+5V_SB		+5V_SB	39	1
41	PEx1_2Clkp		PEx1_3Clkp	42	1			42	PEx1_3Clkp		PEx1_2Clkp	41	1
43	PEx1_2Clkn		PEx1_3Clkn	44	1			44	PEx1_3Clkn		PEx1_2Clkn	43	1
45	DIR		PWRGOOD	46	1			46	PWRGOOD		DIR	45	٦
47	SMB_DAT		Reserved	48	1			48	Reserved		SMB_DAT	47	1
49	SMB_CLK		Reserved	50	1			50	Reserved	1	SMB_CLK	49	٦
51	SMB_ALERT		PSON#	52	1			52	PSON#	1	SMB_ALERT	51	٦

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2.4.1 Type 1 x16 PCI Express Link

Type 1 connector banks 2 and 3 provide an x16 PCI Express link. The x16 Link allows maximum flexibility, configurability, and expandability for current and future designs. Some examples of x16 Link application are next generation graphics chips, 1/10 gigabit Ethernet chips, or use with a PCI Express Switch which can then branch the high throughput out into any number of various size Links including multiple x16 Link graphics engines. The only limitation is the bandwidth requirement for each of the branched links.

The specification allows the x16 Link on a Type 1 PCIe/104 to be configured for alternate PCI Express configurations. These include two x8 Links, two x4 Links, or an Alternate Function defined by the CPU/chipset. These alternate configurations are Host and Device dependent. A Host that supports an x16 Link is not required to support an Alternate Function, two x8, or two x4 Links. Also, a device that supports operation at x16 is not required to support operation at x8 or x4.

2.4.1.1 Two x8 or x4 Links

Two x8 or two x4 PCI Express links can be provided on the x16 Link connectors pins. When a Device uses one of the Links, the other Link is shifted according to the same rules as the x1 Links. With host support, each x8 Link may also be used as an x4 Link.

Because there is only one clock provided for the x16 Link and potentially two devices when operating as x8 or x4, any Device that operates at x8 or x4 must re-drive the clock. The clock must not incur more than 10ns of phase delay when it is re-driven.

The pin assignments for the x8 and x4 Links are shown in Table 2-6 below.

Table 2-6: x16 Link as Two x8 or Two x4 Links Top Connector

Host	Transmit Sign	als	Host Receive Signals			
x16 Signal	x8 Signal	x4 Signal	x16 Signal	x8 Signal	x4 Signal	
PEx16_0T(0)	PEx8_0T(0)	PEx4_0T(0)	PEx16_0R(0)	PEx8_0R(0)	PEx4_0R(0)	
PEx16_0T(1)	PEx8_0T(1)	PEx4_0T(1)	PEx16_0R(1)	PEx8_0R(1)	PEx4_0R(1)	
PEx16_0T(2)	PEx8_0T(2)	PEx4_0T(2)	PEx16_0R(2)	PEx8_0R(2)	PEx4_0R(2)	
PEx16_0T(3)	PEx8_0T(3)	PEx4_0T(3)	PEx16_0R(3)	PEx8_0R(3)	PEx4_0R(3)	
PEx16_0T(4)	PEx8_0T(4)		PEx16_0R(4)	PEx8_0R(4)		

Table 2-6: x16 Link as Two x8 or Two x4 Links Top Connector

Host	Transmit Sign	als	Host Receive Signals				
x16 Signal	x8 Signal	x4 Signal	x16 Signal	x8 Signal	x4 Signal		
PEx16_0T(5)	PEx8_0T(5)		PEx16_0R(5)	PEx8_0R(5)			
PEx16_0T(6)	PEx8_0T(6)		PEx16_0R(6)	PEx8_0R(6)			
PEx16_0T(7)	PEx8_0T(7)		PEx16_0R(7)	PEx8_0R(7)			
PEx16_0T(8)	PEx8_1T(0)	PEx4_1T(0)	PEx16_0R(8)	PEx8_1R(0)	PEx4_1R(0)		
PEx16_0T(9)	PEx8_1T(1)	PEx4_1T(1)	PEx16_0R(9)	PEx8_1R(1)	PEx4_1R(1)		
PEx16_0T(10)	PEx8_1T(2)	PEx4_1T(2)	PEx16_0R(10)	PEx8_1R(2)	PEx4_1R(2)		
PEx16_0T(11)	PEx8_1T(3)	PEx4_1T(3)	PEx16_0R(11)	PEx8_1R(3)	PEx4_1R(3)		
PEx16_0T(12)	PEx8_1T(4)		PEx16_0R(12)	PEx8_1R(4)			
PEx16_0T(13)	PEx8_1T(5)		PEx16_0R(13)	PEx8_1R(5)			
PEx16_0T(14)	PEx8_1T(6)		PEx16_0R(14)	PEx8_1R(6)			
PEx16_0T(15)	PEx8_1T(7)		PEx16_0R(15)	PEx8_1R(7)			

Table 2-7: x16 Link as Two x8 or Two x4 Links Bottom Connector

Host	Transmit Sign	als	Host Receive Signals				
x16 Signal	x8 Signal	x4 Signal	x16 Signal	x8 Signal	x4 Signal		
PEx16_0T(0)	PEx8_1T(0)	PEx4_1T(0)	PEx16_0R(0)	PEx8_1R(0)	PEx4_1R(0)		
PEx16_0T(1)	PEx8_1T(1)	PEx4_1T(1)	PEx16_0R(1)	PEx8_1R(1)	PEx4_1R(1)		
PEx16_0T(2)	PEx8_1T(2)	PEx4_1T(2)	PEx16_0R(2)	PEx8_1R(2)	PEx4_1R(2)		
PEx16_0T(3)	PEx8_1T(3)	PEx4_1T(3)	PEx16_0R(3)	PEx8_1R(3)	PEx4_1R(3)		
PEx16_0T(4)	PEx8_1T(4)		PEx16_0R(4)	PEx8_1R(4)			
PEx16_0T(5)	PEx8_1T(5)		PEx16_0R(5)	PEx8_1R(5)			
PEx16_0T(6)	PEx8_1T(6)		PEx16_0R(6)	PEx8_1R(6)			
PEx16_0T(7)	PEx8_1T(7)		PEx16_0R(7)	PEx8_1R(7)			
PEx16_0T(8)	PEx8_0T(0)	PEx4_0T(0)	PEx16_0R(8)	PEx8_0R(0)	PEx4_0R(0)		
PEx16_0T(9)	PEx8_0T(1)	PEx4_0T(1)	PEx16_0R(9)	PEx8_0R(1)	PEx4_0R(1)		
PEx16_0T(10)	PEx8_0T(2)	PEx4_0T(2)	PEx16_0R(10)	PEx8_0R(2)	PEx4_0R(2)		
PEx16_0T(11)	PEx8_0T(3)	PEx4_0T(3)	PEx16_0R(11)	PEx8_0R(3)	PEx4_0R(3)		
PEx16_0T(12)	PEx8_0T(4)		PEx16_0R(12)	PEx8_0R(4)			
PEx16_0T(13)	PEx8_0T(5)		PEx16_0R(13)	PEx8_0R(5)			
PEx16_0T(14)	PEx8_0T(6)		PEx16_0R(14)	PEx8_0R(6)			
PEx16_0T(15)	PEx8_0T(7)		PEx16_0R(15)	PEx8_0R(7)	·		

2.4.2 PEG_ENA# Signal

The PEG_ENA# signal is used to indicate the presence of a device on the x16 Link. This signal is pulled up at the Host. Any Device that uses the x16 Link (or the x16 as an x8 or x4) attaches this signal to ground. When the Host sees this signal high, indicating that an x16 Device is not present, it may disable the x16 Link, or convert it to alternate uses, such as Alternate Functions as defined by the CPU/chipset.

2.4.3 DIR Signal

The DIR line provides a means for the Devices to select the correct PCI Express, SATA, or USB Link depending if it is above or below the Host in the stack.

2.4.3.1 DIR Line on Host

The state of the DIR line is always determined by the Host so that the Devices can be designed without regards to the design of other Devices. On the top side connector this line must be tied to ground on the Host. On the bottom side connector the DIR line must be tied to +5 volt power during all implemented power saving modes except power completely off. A Host that supports suspend modes may want to use +5V_Aux diode Ored with +5V in case the power supply does not provide +5V_Aux. Shown in Figure 2-1 is the required PCB connection for the DIR line on the Host.

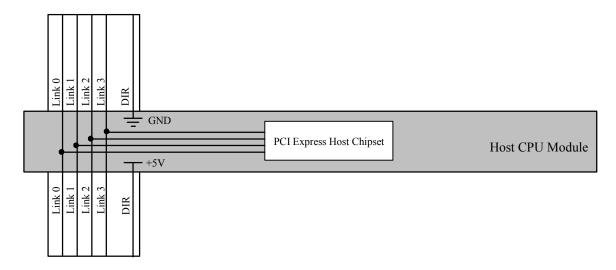


Figure 2-1 Required Circuitry for a Host Module Configuration for Automatic Link Shifting

2.4.3.2 DIR Line on Device

On the Device the DIR line is an input to the resident auto-switching multiplexers. A resistor divider is required on the DIR line on each Device to adjust the SELECT line voltage for the switches. Each Device must sink or source less than 300uA of current. Therefore, the divider resistors R1 and R2 shown in Figure 2-2 must total 15K or greater.

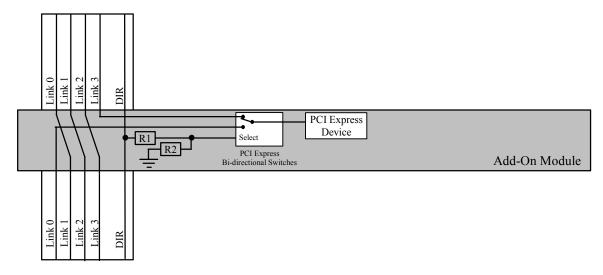


Figure 2-2 Required Device Circuitry for Automatic Link Shifting

If the Device is positioned above the Host, then the DIR signal would be grounded and the SELECT line of the multiplexers would allow Link 0 to connect to the PCI device. Links 1, 2, and 3 are then allowed to shift and pass over so that Link 1 is in the Link 0 position, Link 2 is in the Link 1 position, and Link 3 is in the Link 2 position. A left-most Link is now available for the next Device card to be stacked above the first Device.

If the Device is stacked below the module, then the DIR line would be set to +5V and the SELECT line of the multiplexers would allow Link 3 to connect to the PCI device. Links 0, 1, and 2 are then allowed to shift and pass over so that Link 2 is in the Link 3 position, Link 1 is in the Link 2 position, and Link 0 is in the Link 1 position. A right-most link is now available for the next Device card to be stacked below the first Device.

All Devices can be built using the same methodology as a single configuration. The Links used will always be the left most links or the rights most links depending if the Device gets stacked above or below the Host. Stack-UP or Stack-DOWN Link Shifting

2.4.4 Stack-UP or Stack-DOWN Link Shifting

Within the different connector types and configurations, Connector A contains differential Link Groups. These include x1/x4/x8 PCI Express, USB 2.0, USB 3.0, and SATA. Within each group are individual point-to-point links which must be automatically shifted if one or more links out of that group are used on a Device. The x16 PCI Express, LPC, SMB, power, and control signals do not require Link shifting.

Link shifting is utilized so that Devices can be built uniformly and consistently while using dedicated point-to-point connections. Without link shifting, Devices would have to be made with a specific link identified. This would then require each Device to have multiple configurations, one for each link position. Link shifting at the PCB level allows each Device to have only one universal configuration.

In cases where less than the maximum number of features is provided by the Host (for example 2 PCIe x1 links instead of 4), the designer must place them in the positions that enable them to be used by add-on modules. If the host provides for top side expansion, the features should be positioned on the connector starting with the lowest numbered feature. If the host provides for bottom side expansion, the features should be positioned starting with the highest numbered feature.

Note: If the host has the same expansion bus links connected to both the top and bottom connectors, devices using these links should not be stacked both above and below the Host at the same time, in order to avoid signal integrity degradation due to signal path stubs.

2.4.5 Link Shifting PCB Examples

As a demonstration of link shifting in the presence of multiple link groups, the x1 PCI Express, x4 PCI Express, USB 2.0, USB 3.0, and SATA link groups are used in Figure 2-3: Automatic Link Shifting Examples for Host and Various Devices. Any Device may use one or more Links from any group. If multiple Links are used then the necessary link shifting must be implemented on the Device PCB for each Link and Link Group. For example, in the case where two x1 Link devices are resident on the Device, it is required that the remaining two unused Links be shifted two locations in order that other Devices be able to use the remaining Links. It is not enough to shift only one link space as in the case of a one x1 Link Device.

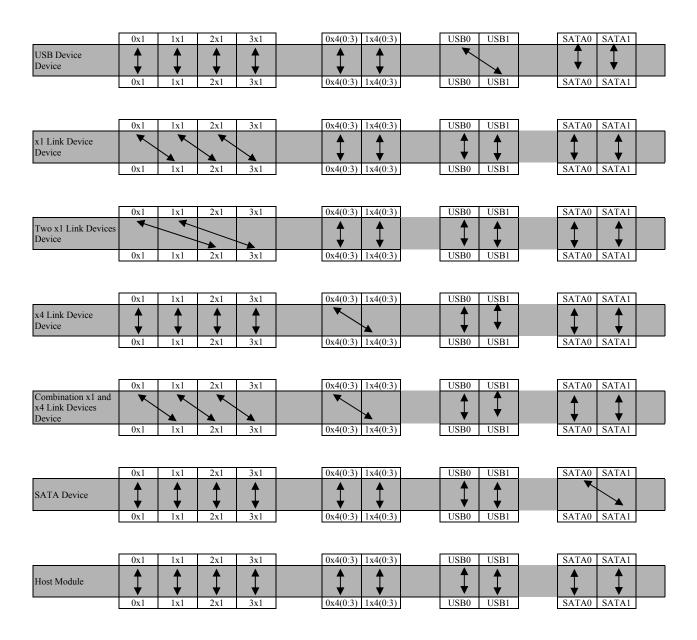


Figure 2-3: Automatic Link Shifting Examples for Host and Various Devices

2.4.6 Link Shifting Stack Examples

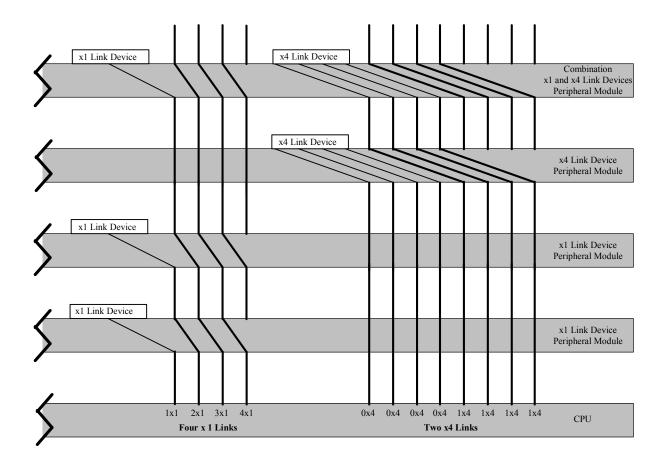


Figure 2-4: Automatic Link Shifting Stack-Up Example Consisting of Two x1 Link Device, One x4 Link Device, and One Device with One x1 Link and One x4 Link

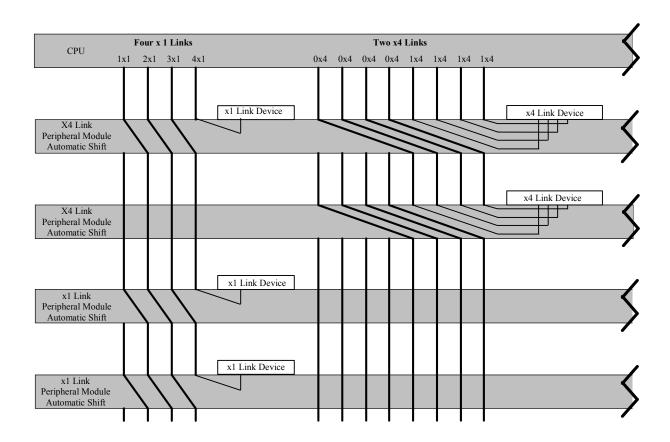


Figure 2-5: Automatic Link Shifting Stack-Down Example Consisting of Two x1 Link Device, One x4 Link Device, and One Device with One x1 Link and One x4 Link

2.5. Switching

To ensure that all Device modules can be stacked up or down without manual configuration a signal switch is required on the Device. The switch is only required on interface being used. For example a SATA Device will have a switch on the SATA link, but will not have switches on USB 3.0 or PCI Express links.

2.5.1 Signal Switch

A signal switch is an analog multiplexer that can be used to select between the link on top connector or the bottom connector. This switch must be able to perform well at the high data rates found in the PCI Express, SATA, or USB 3.0 signaling environment.

Several initial candidates for signal switches have been identified and listed in Table 2-8. These switches have advertised specifications that meet the requirements of the application but have not been independently verified. Equivalent substitutes are permitted.

Manufacturer	Part Number	Application
Texas Instruments	TS2PCIE2212	PCIe 1
Pericom	PI2PCIE2442	PCIe 1
Texas Instruments	DS25MB100	PCIe 1
NXP	CBTU0808EE/G	PCIe 1
Pericom	PI2PCIE2442	PCIe 2
Maxim	MAX4889A	PCIe 2
Pericom	PI3PCIE3412	PCIe 3
Pericom	PI2USB3212	USB 3.0
Pericom	PI2DBS212	SATA 3
NXP	CBTU04083	PCIe 3, SATA 6 or USB 3.0

Table 2-8: Signal Switches or equivalent

2.6. System Clocking

The PCI Express architecture is based on a 100 MHz reference clock that is distributed from the Host to the Devices.

The Host may employ spread spectrum clocking as defined in the PCI Express Base Specification to reduce EMI. For this reason it is recommended that Devices always use the distributed clock as its reference clock. Using an on-board oscillator as a reference is not allowed.

PCIe/104 does not provide for any termination on unused clock lines, therefore the Host is required to disable any unused clocks.

Because there is only one clock provided for the Type 1 PCI Express x16 Link or the Type 2 PCI Express x4 links and potentially two devices, any Device that operates at x8 or x4 must re-drive the clock. The clock must not incur more than 10ns of phase delay when it is re-driven.

2.7. Layout Recommendations

The Data rate for PCI Express Generation 1 is 2.5 Gbps, Generation 2 is 5.0 Gbps, and Generation 3 is 8.0 Gbps. This means that significant frequency content exists up to 1.25 GHz for Generation 1, 2.50 GHz for Generation 2, and 4.0GHz for Generation 3. At these speeds, PCB layout becomes very critical. Therefore, the following recommendations should be followed to avoid signal integrity problems:

- Route all PCI Express signal lines (Transmit and Receive) as controlled impedance using microstrip, stripline, or similar techniques.
 - \circ 68 105Ω differential pairs, 85Ω recommended.
- Spacing from a link to its neighbor must be at least 20 mils (0.51 mm) in the main routing region, 15 mils (0.38 mm) for stripline breakout, and 12 mils (0.30 mm) for microstrip breakout.
- Symmetrical routing must be used between the two signals of a differential pair.
- Signals in a differential pair must be matched to within 5 mils (0.13 mm).
- AC coupling capacitors must be provided on the TX lines. Values should be between 75nF and 200nF. A surface mount capacitor must be used.
- All PCI Express signals should be routed in an adjacent layer to a ground plane.
- There shall be no stubs except the short stub caused by the unused end of the Host connector. SI testing has shown this very short stub to be insignificant in a system with a Host and 6 add-in cards. No stubs are recommended on the Host at Gen 2.
- Do not use 90 degree bends. Use 45 degree bends or curves.

Location	Max. Vias	Max. Trace Length mil (mm)	Notes
Host TX lines Gen 1 & 2	4	6000 (152.40)	Both sides of AC capacitor
Host TX lines Gen 3	4	4000 (101.60)	Both sides of AC capacitor
Host RX lines Gen 1 & 2	2	6000 (152.40)	
Host RX lines Gen 3	2	4000 (101.60)	
Device TX Lines	4	4000 (101.60)	Both sides of signal switch.
Device RX lines	4	4000 (101.60)	Both sides of signal switch.
Pass-through (lane shifting)	2	1000 (25.40)	Includes stack height

Table 2-9: Via and Trace Length Budget

2.7.1 Stitching Capacitors

Bypass these pins with a 0.01uF capacitor to ground as close as possible to the pin. This will ensure a good return path to ground for all clock signals.

- Pin 39, 5V SB
- Pin 40, 5V SB
- Pin 45, DIR
- Pin 46, PWRGOOD
- Pin 52, PSON#

2.7.2 Number of PCI Express Boards in the Stack

The last PCI Express Generation 1, SATA 1 or SATA 2 peripheral in a stack shall have no more than 10 boards between it and the host. The last PCI Express Generation 2 or USB 3.0 peripheral in a stack shall have no more than 9 boards between it and the host. The last PCI Express Generation 3 or SATA 3 peripheral in a stack shall have no more than 5 boards between it and the host.

2.8. Routing Topology

2.8.1 PCI Express and USB 3.0

Figure 2-6 below shows the positioning of the DC blocking capacitor and PCIe/104 connector in relation to the Host and Device. The DC blocking capacitor is placed on the transmit signals. This will be the signals the Host drives onto the Tx bus connector's pins and the signals the Device drives onto the Rx signals of the connector. The actual position is not critical; however the position must be closely matched between the signals of a differential pair.

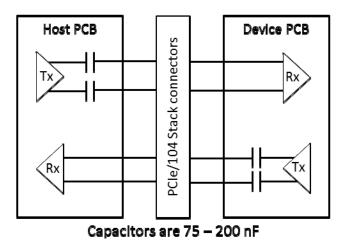


Figure 2-6 PCI Express and USB 3.0 Capacitor Placement

Table 2-10 below list the general guide lines for PCI Express routing.

Table 2-10 PCI Express and USB 3.0 Routing Specification

Interface	Differential Impedance (Ohm)	Matching in a pair mil (mm)	Matching pair to pair mil (mm)
PCIe Gen 1, 2 & 3 Capable	85 ±15%	5 (0.13)	Not required
PCIe Gen 1 only	100 ±20%	5 (0.13)	Not required
PCIe Pass Through	85 ±15%	5 (0.13)	Not required
USB 3.0	96 ±15%	N/A	N/A

2.8.2 SATA

Figure 2-7 below shows the positioning of the DC blocking capacitor and PCIe/104 connector in relation to the Host and Device. The DC blocking capacitor is placed on the transmit and receive signals. The actual position is not critical; however the position must be closely matched between the signals of a differential pair. Note that a SATA device typically has internal capacitors, if so capacitors on the PCB are not required.

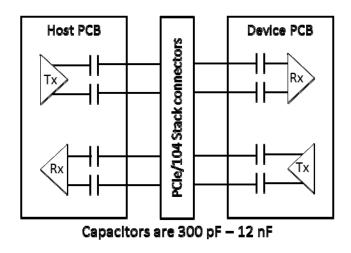


Figure 2-7 SATA Capacitor Placement

Table 2-11 below lists the general guide lines for SATA routing.

Table 2-11 SATA Routing Specification

Interface	Differential Impedance	Matching in a pair	Matching pair to pair
Interface	(Ohm)	mil (mm)	mil (mm)
SATA	100 ±15%	N/A	N/A

2.9. Device Connector Break-out Examples

These drawings are not to scale and do not show controlled impedance lines. They are intended to show the general connections and lane shifting on a device for various PCIe/104 devices that can be stacked above or below the CPU. All power, ground, and unused signals have the top and bottom connectors connected together. The examples show the device on the top of the board; however that is not a requirement.

2.9.1 Universal PCI Express x1 Device Layout Example

Figure 2-8 below shows an example of routing a Universal x1 PCI Express link from the PCIe/104 connector to a Signal Switch. This device can be stacked either above or below the CPU and implements lane shifting.

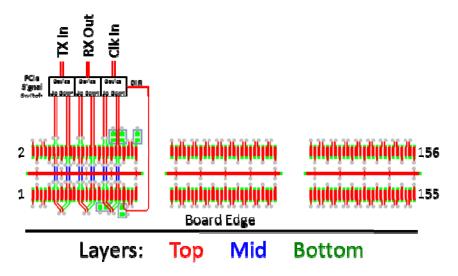


Figure 2-8 Example breakout routing of a Universal PCI Express x1 link with shifting.

2.9.2 Universal PCI Express x4 Device Layout Example

Figure 2-9 below shows an example of routing a Universal x4 PCI Express link from the PCIe/104 connector to a Signal Switch. This device can be stacked either above or below the CPU and implements lane shifting.

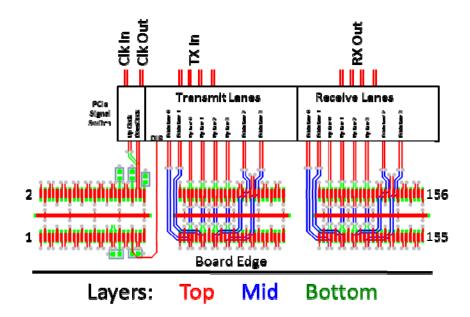


Figure 2-9 Example breakout routing a Universal PCI Express x4 link with lane shifting.

2.9.3 Type 1 PCI Express x8 Device Layout Example

Figure 2-10 below shows an example of routing a Type 1 x8 PCI Express link from the PCIe/104 connector directly to a PCI Express x8 device. This device is shown as a stack down version and implements lane shifting.

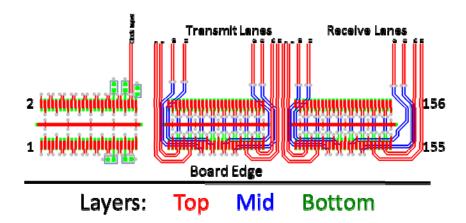


Figure 2-10 Example breakout routing a PCI Express x8 device stacking down with lane shifting

2.9.4 Type 1 PCI Express x16 Device Layout Example

Figure 2-11 below shows an example of the routing from the Device connector directly to a PCI Express x16 device. This example is stack down and does not use lane shifting since the x16 device uses all of the lanes on the link.

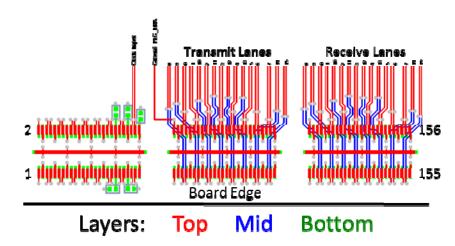


Figure 2-11 Example breakout routing a PCI Express x16 device stacking down

2.9.5 Type 2 USB 3.0 Device Layout Example

Figure 2-12 below shows an example of routing an USB 3.0 link from the PCIe/104 connector to a Signal Switch. This device can be stacked either above or below the CPU and implements lane shifting. USB 3.0 requires that each USB 3.0 port to be associated with a USB 2.0 port as shown in this example.

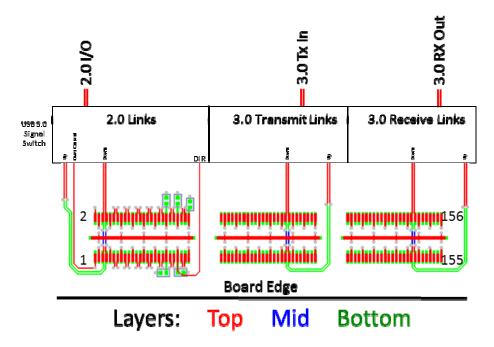


Figure 2-12 Example breakout routing an USB 3.0 device with lane shifting

2.9.6 Type 2 SATA Device Layout Example

Figure 2-13 below shows an example of routing a SATA link from the PCIe/104 connector to a Signal Switch. This device can be stacked either above or below the CPU and implements lane shifting.

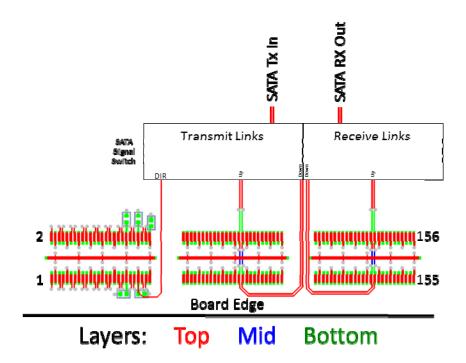


Figure 2-13 Example breakout routing a SATA device with lane shifting

3. EXPANSION CONNECTOR B

3.1. Description

Expansion Connector B is the stackable PCI Expansion connector of the PC/104-*Plus* and PCI-104 specifications. For full details and connector location see the PC/104-*Plus* or PCI-104 Specifications published by the PC/104 Consortium

3.2. Functions

- Four 32 bit, 33 MHz PCI Bus Links each capable of Bus Mastering
- +5V_SB, PSON#, PME# for ATX power management
- Power: +3.3V, +5V, +12V, -12V

3.3. Signal Descriptions

Table 3-1 Connector B Signals

# Pins	Signal Name	Group	Description
32	AD[31:00]		Address and Data are multiplexed on the same PCI pins. A bus transaction
3 2	115[31.00]		consists of an address phase followed by one or more data phases.
			Bus Command/Byte Enables are multiplexed. During the address phase of
4	C/BE[0,3]#		a transaction, they define the bus command. During the data phase, they are used as byte enables.
			Parity is even parity across AD [31:00] and C/BE [3:0]#. Parity generation
1	PAR		is required by all PCI signals.
1	FRAME#		Cycle Frame is driven by the current master to indicate the beginning of an
			access and will remain active until the final data cycle.
1	TRDY#		Target Ready indicates the selected device's ability to complete the current data phase of the transaction. Both IRDY# and TRDY# must be asserted to
1	IKD1#		terminate a data cycle.
			Initiator Ready indicates the bus master's ability to complete the current
1	IRDY#		data phase of the transaction.
_	amaz //		Stop indicates the current selected device is requesting the master to stop the
1	STOP#		current transaction.
1	DEVICE! "		Device Select, when actively driven, indicates the driving device has
1	DEVSEL#		decoded its address as the target of the current access.
4	IDSEL [0.2]	PCI Bus	Initialization Device Select is used as a chip-select during configuration
4	IDSEL[0,3]		read and write transactions.
1	LOCK#		Lock indicates an atomic operation to a bridge that may require multiple
1			transactions to complete.
1	PERR#		Parity Error is for reporting data parity errors.
1	SERR#		System Error is for reporting address parity errors.
4	REQ#[0,3]		Request indicates to the arbitrator that this device desires use of the bus.
4	GNT#[0,3]		Grant indicates to the requesting device that access has been granted.
4	CLK[0,3]		Clock provides timing for all transactions on the PCI bus and is an input to every PCI device.
			Reset is used to bring PCI-specific registers, sequencers, and signals to a
1	RST#		consistent state.
			66 MHz Enable indicates to a device whether the bus segment is operating
1	M66EN		at 33 MHz or 66 MHz. The PCI bus has been simulated at 33MHz. For the
			purpose of this specification, 66MHz is not supported.
1	INTA#		Interrupt A is used to request Interrupts.
1	INTB#		Interrupt B is used to request Interrupts.
1	INTC#		Interrupt C is used to request Interrupts.
1	INTD#		Interrupt D is used to request Interrupts.
1	PME#	ATX	Power Management Event such as wake-on-LAN
1	+5V_SB	Power	Standby Power for advanced power saving modes. Always on
1	PSON#	Supply	Power Supply On brings the ATX power supply out of sleep mode.
5	VI/O		
10	+3.3V		+3.3V power lines
8	+5V	D	+5V power lines
1	+12V	Power	+12V power line
1	-12V		-12V power line
25	GND		Ground lines

Table 3-1 shows only the required pins, arranged in functional groups, which are required for the stackable PCI Expansion bus. This version of the PCI bus is intended as a 32-bit bus running at 33MHz as defined in the *PCI Local Bus Specification Revision 2.2*, and therefore, 64-bit extension and 66MHz¹ are not supported at this time. Also not supported are the boundary scan features (JTAG), *Present* (PRSNT [1:2]#), and *Clock running* (CLKRUN#). The direction indication on the pins assumes a combination master/target device.

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¹ The PCI bus has been simulated at 33MHz. For the purpose of this specification, 66MHz is not supported. To support future enhancements, the M66EN signal should be grounded on any module that cannot support 66MHz and left open for modules that can support a 66MHz clock.

3.4. Pin Assignment

Signals are assigned in the same relative order as in the PCI Local Bus Specification Revision 2.2, but transformed to the corresponding header connector pins. Because of the stack-through nature of the bus, slot-specific signals are duplicated for each plug-in module. The system has been designed to accommodate 4 modules, which are PC/104-*Plus*, PCI-104, or a combination of the two, so multiple sets of the signals have been duplicated to accommodate one signal for each module. These four signal groups include: IDSEL[3:0], CLK[3:0], REQ#[3:0], GNT#[3:0]. Signal assignments for the J3/P3 connector are given in Table 3-2.

В D AD00**GND** +5V_SB 1 +5V 2 VI/O AD01 3 AD04 4 C/BE0# AD07 GND AD06 5 **GND** AD09 GND 6 AD11 VI/O AD10 M66EN AD14 AD13 7 GND AD12 8 C/BE1# +3.3V9 PSON# SERR# GND PAR +3.3V 10 GND PERR# PME# +3.3V 11 STOP# LOCK# GND 12 +3.3VTRDY# DEVSEL# GND 13 FRAME# IRDY# +3.3VGND C/BE2# 14 GND AD16 15 AD18 AD17 **GND** AD21 AD20 AD19 16 **GND** 17 +3 3V AD23 AD22 +3 3V 18 IDSEL0 IDSEL1 IDSEL2 GND 19 IDSEL3 AD24 C/BE3# VI/O 20 AD26 AD25 GND GND AD28 21 AD29 AD27 22 AD30 GND AD31 23 REQ0# GND REQ1# VI/O 24 REQ2# GNT0# GND +5V 25 GNT2# GNT1# VI/O **GND** 26 CLK0 CLK1 GND 27 CLK2 CLK3 GND 28 INTD# RST# **GND** 29 +12V INTA# INTB# INTC# 30 -12V REQ3# GNT3# GND

Table 3-2 Connector Signal Assignment

3.5. +5V SB, PSON#, and PME#

To support ATX power supplies and power down features three signals have been added to the PCI bus. They are +5V_SB which is a power source that is always present when main power is supplied to the system, PSON# which is a power supple control signal that can turn the power supple on or off, and PME# which can be used to bring the CPU out of power down states such as wake-on-LAN.

These signals have been implemented on the reserved pins of the PCI expansion bus of the PC/104-Plus and PCI-104 Specifications at pins B1, C9, and D10. Not all manufacturers will implement these signals; therefore to maintain compatibility with existing products it is important for designs that implement these functions to protect against undriven inputs.

3.6. PCI Signaling Voltage (VI/O) Requirements

3.6.1 PCI Host Module

The PCI Host board will always determine the PCI signaling level on the bus by setting all VI/O pins to either +3.3V or +5V. If VI/O is set to 3.3V, then the system will use +3.3V I/O signaling and, likewise, if VI/O is set to +5V, then the system will use +5V I/O signaling. Some PCI host modules may only allow one of the options, while others may provide a jumper to allow the user to select the signaling level. Once the signaling level is selected, the remaining boards in the system must use that signaling level.

3.6.2 Add-In Modules

Add-in cards can be 3.3V, 5V, or universal.

3.6.2.1 3.3V Add-In Modules

3.3V add-in modules operate in environments where VI/O has been set to +3.3V by the host module. Using 5V add-in modules on a 3.3V stack will result in the 3.3V modules being damaged.

3.6.2.2 5V Add-In Modules

5V add-in modules operate in environments where VI/O has been set to +5V by the host module. Using 3.3V add-in modules on a 5V stack will result in the 3.3V modules being damaged.

3.6.2.3 Universal Add-In Modules

Universal add-in boards can be used on either 3V or 5V I/O signaling buses. Universal boards either use the VI/O signal to determine its signaling level or are 3V signaling boards that have 5V-tolerant I/O. Many PCI interface chips have a "VI/O" pin that is the power for the I/O buffers that can be directly connected to VI/O. Universal boards will work on either 3V or 5V I/O signaling buses.

4. PCIe/104 Type 1 and Type 2 Stacking

4.1. System Stacking Rules

These rules will insure that the systems are not damaged when different type peripheral boards and host modules are stacked together. A 1-bank implementation is limited to the PCI Express x1and USB 2.0 features noted below; the STKx signals are not present.

Table 4-1 Required Host State When Peripherals Are Placed on Type 1 and Type 2 Hosts

Peripheral Car	Type 1 Host Configuration					
Bus Used	Туре	x16	x8	x4	Alternate Function	Type 2 Host
Alternate Function	1		Reset		Good	Reset
PCI Express x16	1	Good	Good Reset		eset	Reset
PCI Express x8	1	Go	Good Reset		Reset	Reset
PCI Express x4	Universal	Good		Reset	Good	
PCI Express x1	Universal	Good		Good		
USB 2.0	Universal		Good		Good	
USB 3.0	2	Reset			Good	
SATA	2	Reset			Good	
LPC	2			Reset		Good

Table 4-2 Peripheral Effect on Type 1 Host CPU Signals

Bus	Peripheral	53 STK0/WAKE#	54 STK1/PEG_ENA#	105 STK2/SDVO_DAT
Type 1	PCIe x16 or x8	No Change	0 = Enable PCIe x16	No Change
Type 1	Alternate Function	No Change	No Change	1 = Enable GFX
Type 2	SATA, USB 3.0, LPC	0 = Bus Stacking Error	No Change	No Change
Universal	PCIe x4	No Change	0 = Enable PCIe x16	No Change
Universal	PCIe x1, USB 2.0	No Change	No Change	No Change

Table 4-3 Peripheral Effect on Type 2 Host CPU Signals

Bus	Peripheral	53 STK0/WAKE#	54 STK1/PEG_ENA#	105 STK2/SDVO_DAT
Type 1	PCIe x16 or x8	No Change	0 = Bus Stacking Error	No Change
Type 1	Alternate Function	No Change	No Change	1 = Bus Stacking Error
Type 2	SATA, USB 3.0, LPC	0 = Normal Operation	No Change	No Change
Universal	PCIe x4	No Change	1 = Normal Operation	No Change
Universal	PCIe x1, USB 2.0	No Change	No Change	No Change

- The PCI Express signals may always be driven, but it is recommended that they are Hi-Z during reset.
- The system should provide some indication to the user when a bus stacking error has occurred, i.e. a blinking LED.
- A PCI Express Link may only traverse up to six stacked PCI Express connector heights and all PCI Express
 modules should be on the same side of the host if the top and bottom PCI Express connectors are electrically
 connected together.
- A PCI Express Link may only be attached to a single connector on the Host.
- A PCI bus may only traverse up to four stacked PCI connectors, and they must all be on the same side of the
 Host. Because of the requirements of trace length matching, all PCI Devices must be stacked together and must
 be next to the Host

4.2. Host Configuration Rules

There are a set of rules to ensure that improper stacking does not damage either the host or peripheral boards. In addition to connecting the pins as specified in Table 4-5, if a bus stacking error is detected the host shall hold the system in reset. The host can optionally indicate to the user a stacking error.

The signals that need special consideration are: SATA_T[0:3]n, SATA_T[0:3]p, SATA_R[0:3]n, SATA_R[0:3]p, SATA_DET#[0:3], SATA_PWREN#[0:3], LPC_CLK, LPC_AD[0:3], LPC_FRAME#, LPC_SERIRQ#, LPC_DRQ#.

- The CPU SHALL NOT DRIVE these signals until it determines that there is not a Bus Stacking Error.
- If the system detects a bus stacking error, it must remain in reset and not drive these signals.
- The CPU must tolerate PCI Express signal levels on these signals during reset.

The rules for all host CPUs are detailed below and affect the operation of pins 52, 54, and 105 on PCIe/104 Connector A.

Table 4-4 Host CPU Stacking Rules

Host	53 STK0/WAKE#	54 STK1/PEG_ENA#	105 STK2/SDVO_DAT
Type 1	During Reset: 0 = Bus Stacking Error 1 = Normal Operation	0 = Enable PCIe x16 1 = Enable GFX(optional)	0 = Enable PCIe x16 1 = Enable GFX(optional)
Type 2	0 = Normal Operation 1 = Normal Operation	0 = Bus Stacking Error 1 = Normal Operation	0 = Normal Operation 1 = Bus Stacking Error

Table 4-5 Required Host Connector A Pin Configuration

Host Type	53 STK0/WAKE#	54 STK1/PEG_ENA#	105 STK2/SDVO_DAT
Type 1	Input (100K Pull-up)	Input (100K Pull-up)	Input (100K Pull-down)
Type 2	Input (100K Pull-up)	Input (1K Pull-up):	Input (100K Pull-down):

• All pull-ups described above must be to 3.3V that is derived from the +5V_Always supply. If a board does not have the appropriate supply, a Thevenin equivalent resistor divider may be used. All pull-downs are to ground.

4.3. Peripheral Configuration Rules

The signals that need special consideration are: SATA_T[0:3]n, SATA_T[0:3]p, SATA_R[0:3]n, SATA_R[0:3]p, SATA_DET#[0:3], SATA_PWREN#[0:3], LPC_CLK, LPC_AD[0:3], LPC_FRAME#, LPC_SERIRQ#, LPC_DRQ#.

- Peripheral cards MUST NOT DRIVE these signals while PE RST# is asserted.
- The peripheral cards must tolerate PCI Express signal levels on these signals during reset.

Rules guiding peripheral boards are listed in Table 4-6.

Table 4-6 Peripheral Stacking Rules

Bus	Peripheral Interface	53 - STK0/WAKE#	54 – STK1/PEG_ENA#	105 – STK2/SDVO_DAT
Type 1	PCIe x16 or x8	Hi-Z During Reset	Short to GND	Open
Type 1	Alternate Function	Open	Open	1K to 10K Pull-up
Type 2	SATA, USB 3.0, LPC	Short to GND	Open	Open
Universal	PCIe x4	Hi-Z During Reset	10K Pull-down	Open
Universal	PCIe x1 or USB 2.0	Hi-Z During Reset	Open	Open

- All pull-ups described above must be to 3.3V that is derived from the +5V_Always supply. If a board does not have the appropriate supply, a Thevenin equivalent resistor divider may be used.
- A peripheral device must be able to be stacked above or below the Host. Therefore, the peripheral must be capable of selecting the TX, RX, and clock lines from the top connector or the bottom connector.
- If any link(s) from a Link group (PCI Express x1, PCI Express x4, PCI Express x8, USB 2.0, USB 3.0, or SATA) is used on the module, the other links in that group must be shifted to the appropriate positions.
- Any unused signals must be passed between top and bottom using no more than two vias and as short of a trace as possible.

4.4. Stack Configuration Examples

Figure 4-1 illustrates a stack down configuration using PCI/104-Express and PCI-104 peripheral modules. In this configuration the Connector A, PCIe/104, could be either Type 1 or Type 2.

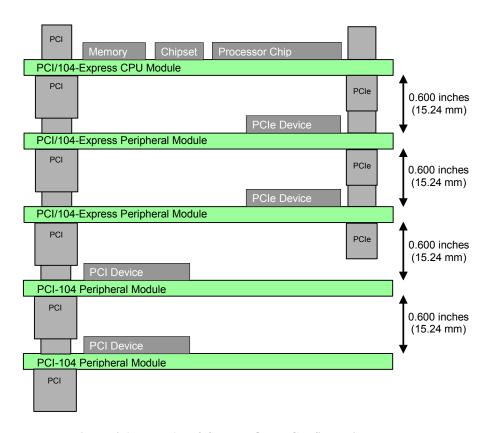


Figure 4-1: Type 1 or 2 Stack-DOWN Configuration Example

Figure 4-2 illustrates putting PCIe/104 and PCI/104-Express peripheral modules on an EPIC Host board. In this configuration Connector A, PCIe/104, could be either Type 1 or Type 2.

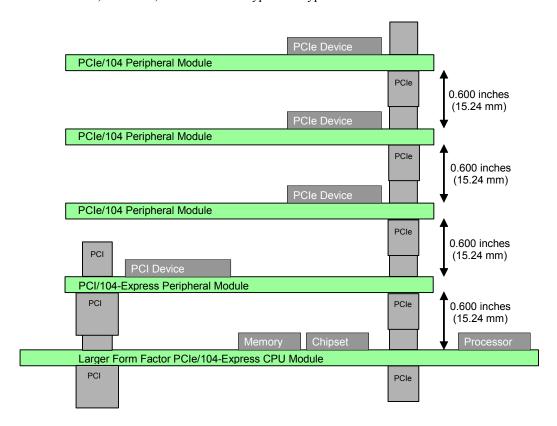


Figure 4-2: Type 1 or 2 Stack-UP Configuration Example with EPIC Host Baseboard

Figure 4-3 illustrates a stack with PCIe/104, PCI/104-Express and PCI-104 peripheral boards. In this configuration Connector A, PCIe/104, could be either Type 1 or Type 2.

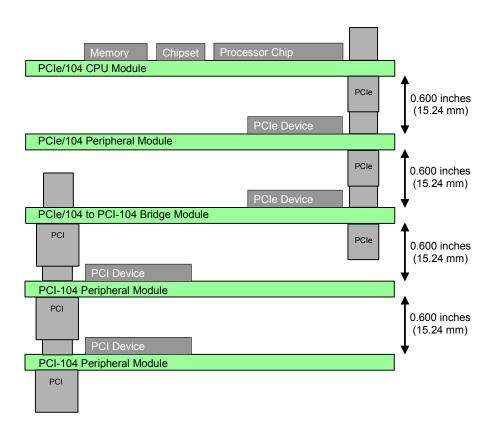


Figure 4-3 PCIe/104 with a PCI Express to PCI Bridge

Figure 4-4 illustrates a stack that has PCI/104-Express Host with the PCIe/104 bus connected top and bottom with PCIe/104, PC/104-Plus, and PCI-104 peripherals. In this configuration Connector A, PCIe/104, could be either Type 1 or Type 2. Because of the requirement that each type of bus must completely reside on one side of the Host in order to avoid bus splits and signal stubs, only PCI-104 and PCIe/104 modules can be used in this configuration. In this example all of the PCI-104 boards are on the bottom side of the Host and all of the PCIe/104 modules are on the top side of the Host. The reverse configuration is also valid.

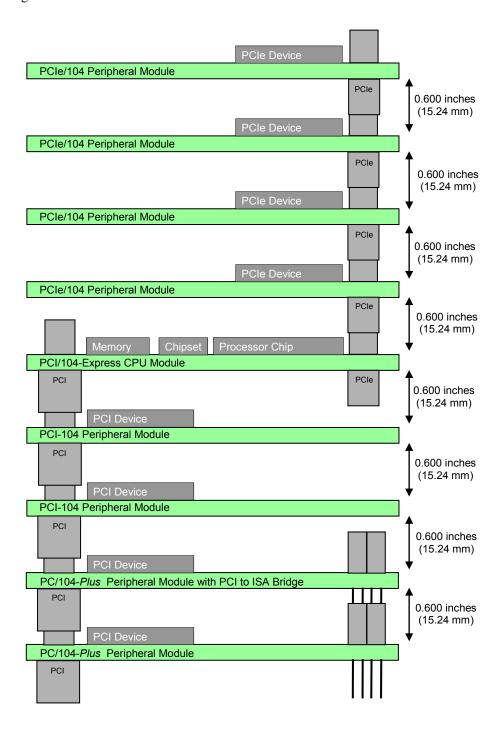


Figure 4-4: PCI/104-Express Combined Stack-UP and Stack-DOWN Configuration Example

Figure 4-5 illustrates a Host with a PCIe/104 Type 1 connector going down and a PCIe/104 Type 2 connector going up. The Host does not have the top and bottom busses connected. Type 1 and Universal Devices are stacked below the Host. Type 2 and Universal Devices are stacked above the Host.

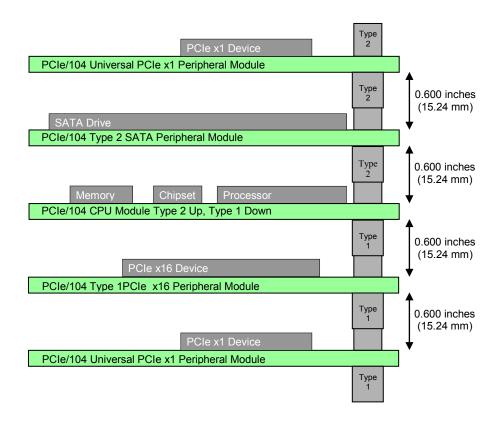


Figure 4-5: PCIe/104 Type 1 Stack-down and Type 2 Stack-up Configuration Example

Figure 4-6 illustrates a Host with a PCIe/104 Type 2 connector going down and a PCIe/104 Type 2 connector going up. The Host does not have the top and bottom busses connected so, as in this example, it can support up to 4 SATA Devices. In this example Type 2 and Universal Devices are stacked either above or below the Host or both at the same time.

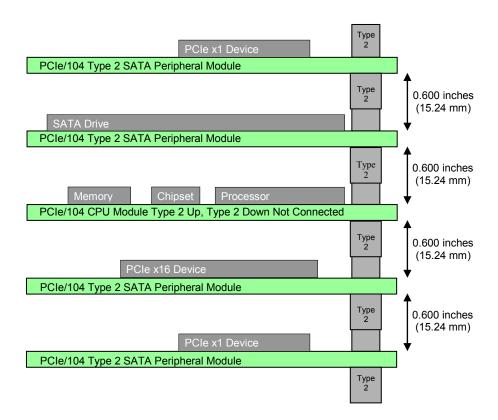


Figure 4-6: PCIe/104 Type 2 Stack-down, Type 2 Stack-up Busses Not Connected Configuration Example

5. ELECTRICAL SPECIFICATION

5.1. Power and Ground

5.1.1 Connector A, PCIe/104, Power Capabilities

The power rails on Connector A are +5V_SB, +3.3V, +5V, and +12V. The +5V and +12V are carried on central conductor planes which are dispersed among the three banks of Connector A. The +5V_SB is carried on individual pins. The current carrying capacities of the central panes and pins are shown in Table 5-1 below. Current values include a 20% industry standard de-rating factor at 85 °C. Note that at lower temperatures the current carrying capacities increase. There is a 2.9 to 1 ratio of current ground to current voltages which helps ensure good current paths.

Voltage	Minimum Voltage (V)	Maximum Voltage (V)	Number of Pins	Current per Pin (A)	Total Current (A)	Total Power (W)
+3.3V	3.00	3.60	2 (2)	1.8	3.6 (3.6)	11.9 (11.9)
+5V	4.75	5.25	2 (1) planes	8.4	16.8 (8.4)	84.0 (42.0)
+12V	11.40	12.60	1 (0) plane	8.4	8.4 (0.0)	100.8 (0.0)
+5V_SB	4.75	5.25	2 (2)	1.8	3.6 (3.6)	18.0 (18.0)
GND	n/a	n/a	46 (10)	1.8	82.8 (18.0)	n/a

Table 5-1 Connector A Power Delivery (OneBank Option)

Standby power is supplied for wake capabilities. Because of the limited amount of power available during standby, it is important for Device cards to be designed to minimize power consumption from the standby rail. Note that during full power operation, the voltage on the Standby rail may exceed the voltage on the +5V rail. Therefore, if powering devices from both the standby and the +5V rail, care must be taken not to exceed the current limits of the Standby rail during normal operation. The +12V rail is intended to provide additional power for high power devices

5.1.2 Connector B, PCI-104, Power Capabilities

Minimum Maximum Number of | Current per Pin Total Current (A) Total Power (W) Voltage Voltage (V) Voltage (V) Pins (A) 10 +3.3V 3.00 3.60 1.0 10.0 33.0 +5V 4.75 5.25 8 1.0 8.0 40.0 +12V 11.4 12.6 1 1.0 1.0 12.0 -12V -12.6 -11.4 1 1.0 1.0 12.0 GND 23 1.0 23.0 n/a n/a n/a

Table 5-2 Connector B Power Delivery

5.1.3 Total PCIe/104 Power Capabilities Connector A Only (OneBank Option)

Table 5-3 Connector A Power Delivery

Voltage	Minimum Voltage (V)	Maximum Voltage (V)	Total Current (A)	Total Power (W)
+3.3V	3.00	3.60	3.6 (3.6)	11.9 (11.9)
+5V	4.75	5.25	16.8 (8.4)	84.0 (42.0)
+12V	11.40	12.60	8.4 (0.0)	100.8 (0.0)
+5V_SB	4.75	5.25	3.6 (3.6)	18.0 (18.0)
GND	n/a	n/a	82.8 (18.0)	n/a

5.1.4 Total PCI/104-Express Power Capabilities Connector A and B (OneBank Option)

Table 5-4 Combined Connector A and B Power Delivery

Voltage	Minimum Voltage (V)	Maximum Voltage (V)	Total Current (A)	Total Power (W)
+3.3V	3.00	3.60	13.6 (13.6)	44.9 (44.9)
+5V	4.75	5.25	24.8 (16.4)	124.0 (82.0)
+12V	11.40	12.60	9.4 (1.0)	112.8 (12.0)
-12V	-12.6	-11.4	1.0 (1.0)	12.0 (12.0)
+5V_SB	4.75	5.25	3.6 (3.6)	18.0 (18.0)
GND	n/a	n/a	105.8	n/a

5.2. AC/DC Signal Specifications

5.2.1 Stackable PCI Express Expansion Bus

For full details on the electrical requirements for the PCI Express bus, reference the *PCI Express Base Specification* referenced in Section 1.9.7.

5.2.1.1 Power and Ground Pins

Power and ground planes are shared among all of the interfaces on Connector A. See Section 2 for more details.

5.2.2 Stackable PCI Expansion Bus

For full details on the electrical requirements for the stackable PCI bus, reference the PC/104-*Plus* or PCI-104 Specifications referenced in Section 1.9.7.

5.2.2.1 Power and Ground Pins

Power and ground planes are shared among all of the interfaces on Connector A. See Section 2 for more details.

5.2.3 System Management Bus (SMBus)

For full details on the electrical requirements for the SMBus, reference the *System Management Bus (SMBus) Specification* referenced in Section 1.9.7.

5.2.3.1 Power and Ground Pins

Power and ground planes are shared among all of the interfaces on Connector A. See Section 2 for more details.

6. MECHANICAL SPECIFICATIONS

6.1. Connector A

Samtec's QMS/QFS High Speed Interface series connectors were optimized for a 0.600" (15.24mm) stacking height and standoff tolerances. Additionally, an optional 22mm top connector was developed to allow additional height above the board. In both height options the bottom connector remains the same. An equivalent connector can be used.

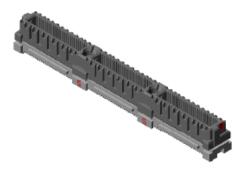
It is permissible to use a OneBank connector for applications that do not require the signals or power in banks 2 and 3. This connector consists of bank 1 pins 1-52 and its +5 volt power blade. All bank 1 signals and power are the same in Type 1 and Type 2, so there is no such distinction when using the OneBank connector. It is recommended that all 3-bank boards in a system be placed closest to the host CPU and then any OneBank boards be placed on the top or bottom of the stack.

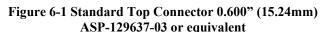
Note: Exercise caution when unplugging boards, especially with the smaller OneBank connectors. The connectors must be kept in alignment and pulled straight apart to prevent damage to the exposed connector post.

6.1.1 Part Number

Top Connector (standard):

ASP-129637-03 with 0.600 inch (15.24 mm) stack height
ASP-142781-03 with 0.866 inch (22.00 mm) stack height
ASP-129637-13 with 0.600 inch (15.24 mm) stack height
ASP-129637-13 with 0.600 inch (15.24 mm) stack height
ASP-129637-13 with 0.600 inch (15.24 mm) stack height
ASP-129646-03 same for either stack height
ASP-129646-22 same for either stack height





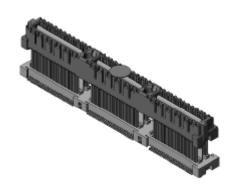


Figure 6-2 Optional Top Connector 0.866" (22.00mm) ASP-142781-03 or equivalent



Figure 6-3 OneBank Top Connector ASP-129637-13 or equivalent Shown with Pick-and-Place Adapter



Figure 6-4: Bottom Connector ASP-129646-03 or equivalent



Figure 6-5: OneBank Bottom Connector ASP-129646-22 or equivalent Shown with Pick-and-Place Adapter

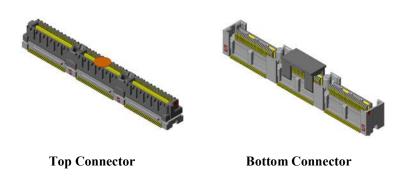


Figure 6-6: Top Half and Bottom Half of Connector A Shown with Pick-and-Place Adapters

6.1.2 Connector A Specifications

MATERIALS

Housing: Liquid Crystal Polymer Terminal & Ground Plane Material: Phosphor Bronze

Terminal Plating: Au over 50μ " (1.27 μ m) Ni Plane Plating: Au over 50μ " (1.27 μ m) Ni

Terminal and Plane Tails: Tin

CONTACT FINISH

Socket Interface: 30μ " Au Terminal Interface: 30μ " Au Underplate: 50μ " Ni

MECHANICAL PERFORMANCE

Insertion Force: 10.6 lbs initial & 12.9 lbs @ 100 cycles Insertion Force OneBank variation: 2.9 lbs initial & 3.3 lbs @ 100 cycles Withdrawal Force: 6.3 lbs initial & 9.3 lbs @ 100 cycles Withdrawal Force OneBank variation: 1.9 lbs initial & 2.6 lbs @ 100 cycles

Normal Force @ nominal deflection: 67 grams
Normal Force @ nominal deflection OneBank: 67 grams

Minimum stacking size:StandardOptionalMominal stacking size:14.8mm21.56mmNominal stacking size:15.24mm22.00mmMaximum stacking size:15.50mm22.26mm

Contact wipe (at nom. Height): .044" [1.22mm]
Ground Plane wipe (at nom. Height): .059" [1.50mm]
Durability: 50 cycles

Operating Temp: -55 °C to 125 °C

ELECTRICAL PERFORMANCE

Positions Three banks of 52 pins and 1 plane for 156 total pins and 3 planes

Optional one bank of 52 pins and 1 plane

Contact Resistance (initial): 30 mOhms Contact Resistance (@ 1,000 cycles): 50 mOhms

Contact Current Capacity: 1.8A at 85 °C and with 20% Industry Standard Derating Factor

Ground Plane Resistance: 0.5 mOhms

Ground Plane Current Capacity: 8.4A at 85 °C and with 20% Industry Standard Derating Factor

Dielectric Withstanding Voltage: 900 VAC Working Voltage: 300 VAC

Insulation Resistance: 50,000 mega Ohms

SOLDERABILITY

Maximum Processing Temperature: 230 °C for 60 seconds or 260 °C for 20 seconds

HIGH FREQUENCY PERFORMANCE

Differential Pair Impedance 100 Ohms nominal +/- 10% Single-Ended Impedance 50 Ohms nominal +/- 10%

Differential Return Loss (SDD11):

-15dB @ 1.25 GHz; -8dB @ 5 GHz

Differential Insertion Loss (SDD21):

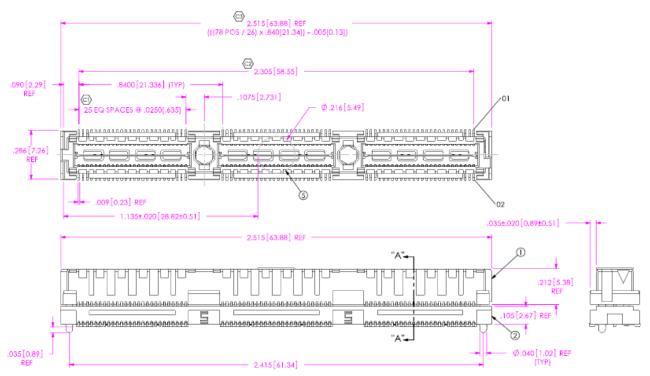
-1dB @ 1.25 GHz; -3dB @ 5 GHz

Differential Near End Crosstalk (SDD31):

-45dB @ 1.25 GHz; -35dB @ 5 GHz

-45dB @ 1.25 GHz; -25 dB @ 5 GHz

6.1.3 Standard 0.600" (15.24mm) Top Connector A Mechanical Drawings



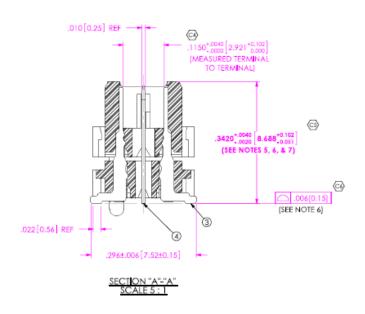
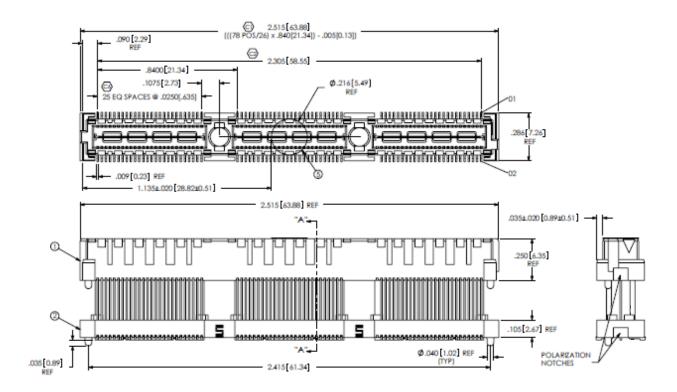


Figure 6-7: Standard 0.600" (15.24mm) Connector ASP-129637-03 or equivalent Mechanical Drawings

6.1.4 Optional 0.866" (22.00mm) Top Connector A Mechanical Drawings



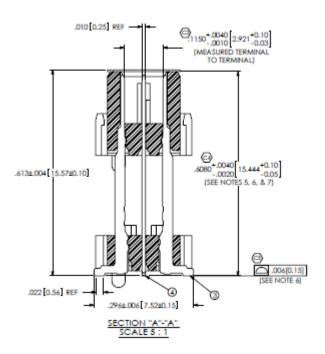


Figure 6-8 Optional 0.866" (22.00mm) Connector ASP-142781-03 or equivalent Mechanical Drawings

6.1.5 Optional OneBank Top Connector A Mechanical Drawings

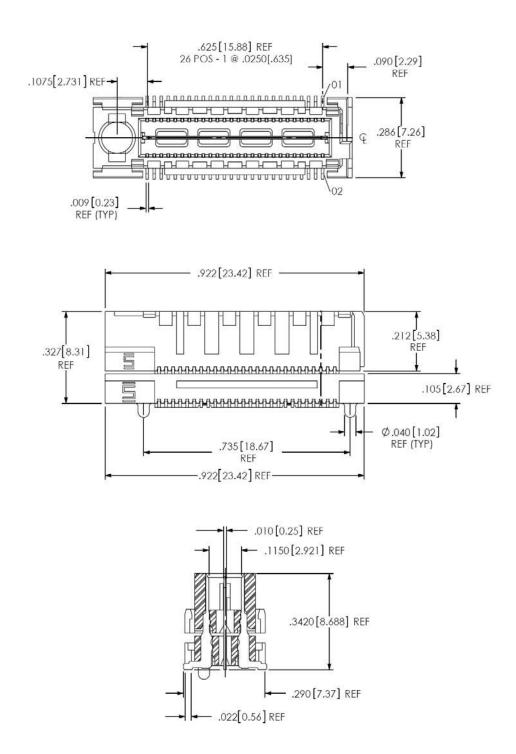
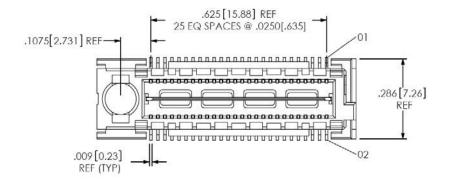
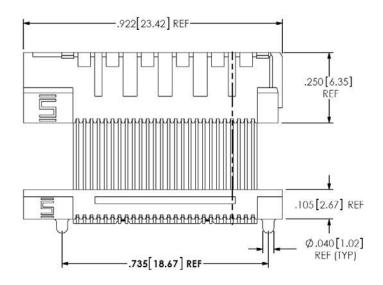


Figure 6-9 Optional OneBank 0.600" (15.24mm) Connector ASP-129637-13 or equivalent Mechanical Drawings





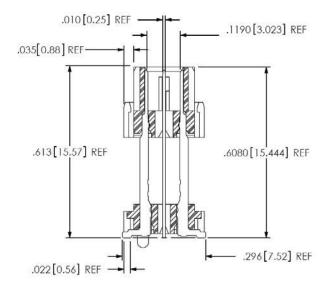
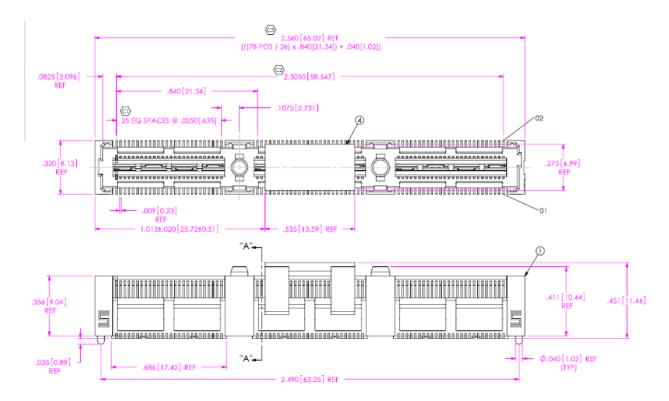


Figure 6-10 Optional OneBank 0.866" (22mm) Connector ASP-142781-07 or equivalent Mechanical Drawings

6.1.6 Standard ASP-129646-03 or equivalent (Bottom Connector) Mechanical Drawings



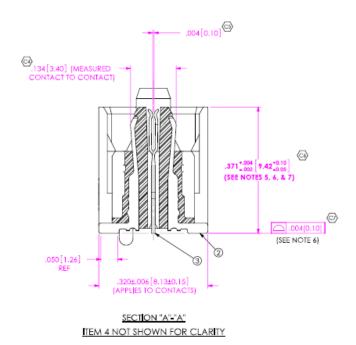


Figure 6-11: Standard ASP-129646-03 or equivalent Mechanical Drawings

6.1.7 Optional ASP-129646-22 (OneBank Bottom Connector) Mechanical Drawings

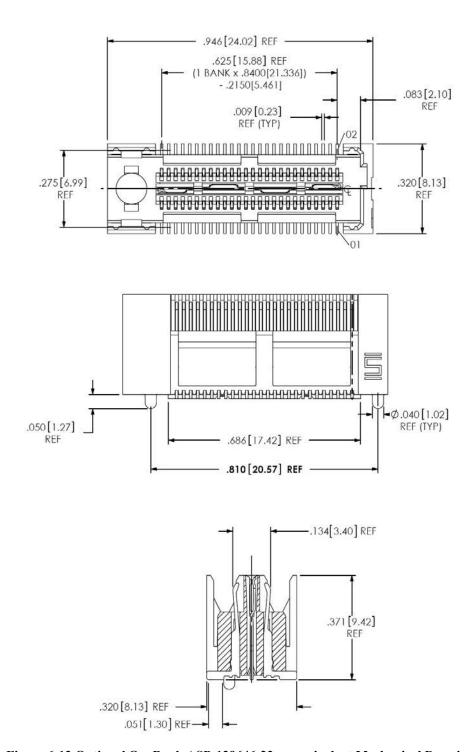


Figure 6-12 Optional OneBank ASP-129646-22 or equivalent Mechanical Drawings

6.2. Connector B

Connector B is the standard PCI bus that is used on PC/104-*Plus* and PCI-104 modules. See the PC/104-*Plus* or PCI-104 Specification for mechanical specification details of the connector.

6.3. Board Layout & Dimensions

6.3.1 PCIe/104 Layout & Dimensions

The outer mechanical dimensions for this module are identical to PCI/104-Express Specification with the exception of the removal of the PCI connector and some modifications to the I/O connector area.

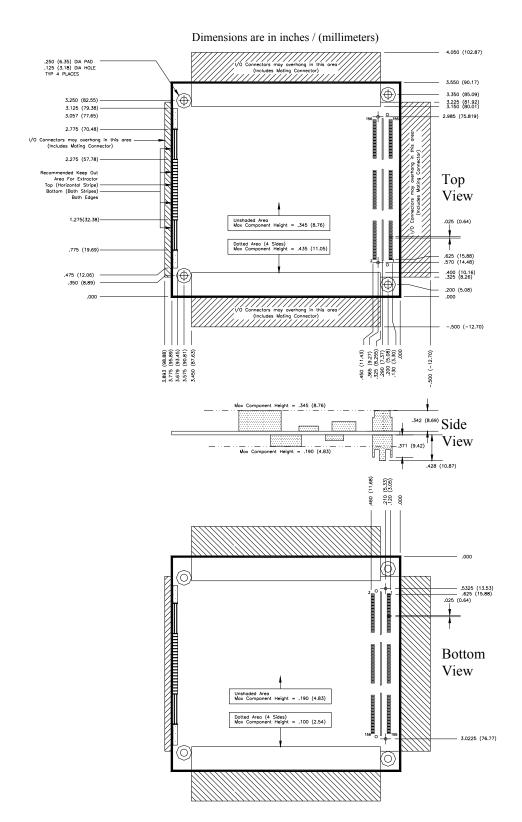


Figure 6-13 PCIe/104 Module Dimensions

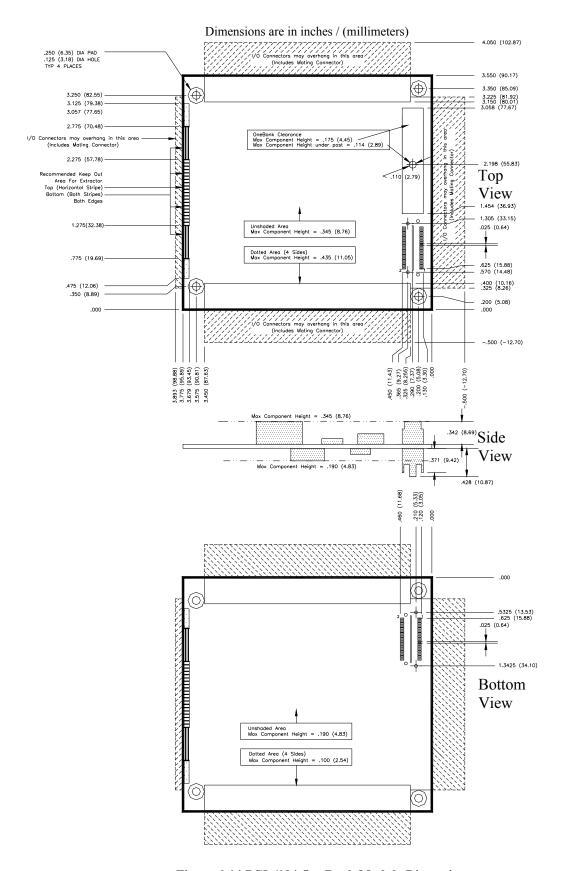


Figure 6-14 PCIe/104 OneBank Module Dimensions

6.3.2 PCI/104-Express Layout & Dimensions

The outer mechanical dimensions for this module are identical to PC/104-*Plus* Specification with the exception of the added connector (J3), modifications to the I/O connector area, and changes to the component height restrictions. The component height on the top has been reduced from 0.435" to 0.345" and the bottom has been increased from 0.100" to 0.190". Exceptions are the three regions on the sides of the module (indicated by the dotted region in Figure 6-15 which have a maximum height of 0.435" for the top and 0.100" for the bottom.

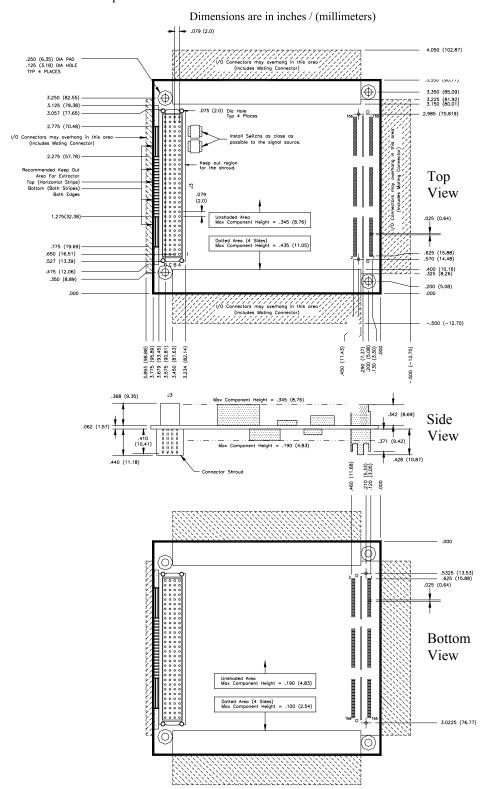


Figure 6-15 PCI/104-Express Module Dimensions

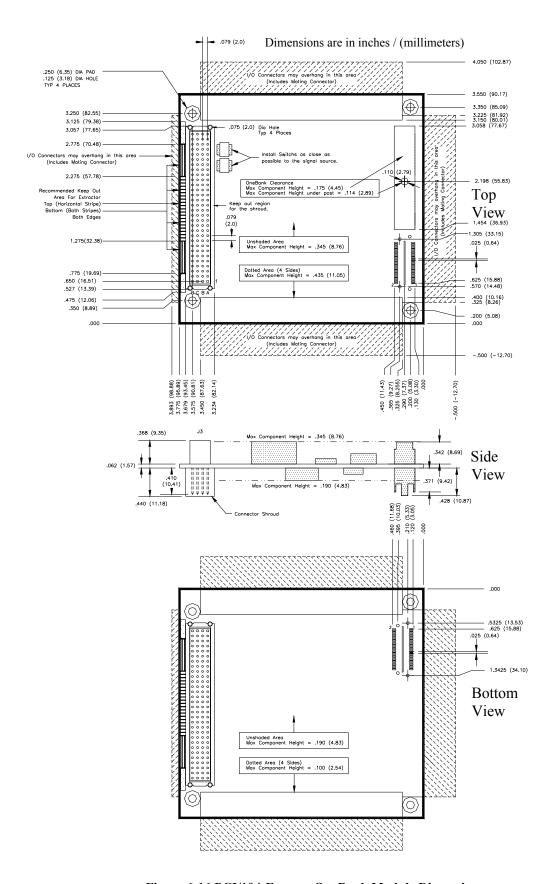


Figure 6-16 PCI/104-Express OneBank Module Dimensions

6.3.3 Connector A Placement Details

Since the QFS (ASP-129646-03) connector is larger than the QMS (ASP-129637-03), the QFS was used to determine the placement of both the QFS and the QMS. The maximum width of the QFS is determined by the recommend solder pad size and placement which is larger than the outer plastic dimensions of the QFS connector. The connector was lined up so that the base of the bottom solder pad lined up with the bottom of the AT ISA connector found on the PC/104 and PC/104-*Plus* form factors. This allows the retention of the traditional keep out region. With this placement the centerline of the connector (which placement should be based on) is located at 0.290 inches (7.37 mm) from the edge of the board.

The horizontal positioning of the QFS connector was calculated by positioning it in the center of the PCB and rounding off to a reasonable even multiple of 0.025 inches (0.635 mm) since this is the distance between two solder pads. The result was the first solder pad being located 0.625 inches (15.875 mm) from the left edge of the PCB as shown in Figure 6-17.

With the placement of the bottom side QFS connector, the QMS connector placement points are determined. The vertical placement point for the QMS is the same as that for the QFS which is 0.290 inches (7.37 mm) from the edge of the PCB to the center planes of the connector.

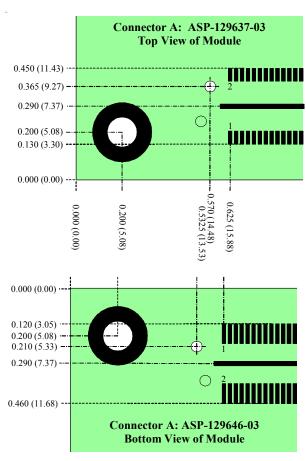


Figure 6-17: Top Side and Bottom Side Views of Connector Placements

Dimensions are in inches / [millimeters]

6.4. Standoff

Standoffs are used to ensure stacked boards retain their connectivity. The standoffs are preferably made from stainless-steel to provide for maximum strength and height tolerance. Pads must be provided for the standoffs, with the same plating as the pads for the PCI Express connectors.

All critical dimensions are listed. It is up to the user to define the thread type. The height of the standoff shall be 0.600 inches ± 0.005 inches $(15.24 \text{mm} \pm 0.127 \text{mm})$.

Optionally, 22mm standoffs are to be used with the optional 22mm connector and they shall be 0.866 inches ± 0.005 inches (22.00mm ± 0.127 mm) all other dimensions remain the same.

The width of the standoff must be able to fit on the Standoff pad called out on the Board Layout & Dimensions Section. The width of the threaded section must be able to fit into the standoff pad hole called out in the Board Layout & Dimensions Section.

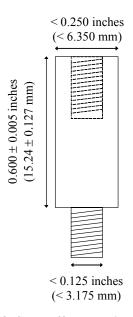


Figure 6-18: Standoff Mechanical Dimensions

APPENDIX A: PC/104 BRIDGE CARD

While advancing the PC/104 family of specifications, maintaining the stackable PCI bus was chosen over the stackable ISA bus for two reasons. First, many current and most future modern chipsets support both PCI and PCI Express. None support ISA. Second, backward compatibility to PC/104, PC/104-Plus, and PCI-104 is mechanically easier to achieve if the stackable PCI bus is retained over the stackable ISA bus.

To realize the stackable ISA bus, one merely needs to create a single board PCI-to-ISA bridge module using off-the-shelf PCI-to-ISA bridge chips or FPGA cores. This will get a basic ISA bus without DMA or IRQs. With the addition of three signals (SDMA_REQ, SDMA_GNT, and SIRQ) which are present on many chipsets and can be cabled to a bridge board, a full ISA bus can be realized for complete backward compatibility to all PC/104 specifications without any mechanical or electrical interference or deficiency issues.

And since the ISA bus is created using a PCI-to-ISA bridge chip, it is a natural electrical and mechanical extension to create the ISA bus off of the PCI expansion bus to support the number of ISA legacy cards already on the market. If the ISA bus was retained then creating a PCI bus off of the PCI Express bus would be easy electrically, but mechanically you have problems because the both the PCI expansion bus and the PCI Express expansion bus would reside in the same location. This would then require a two board solution to support the number of PC/104-*Plus* and PCI-104 cards already on the market.

A.1 Bridge Module Configurations

The PCI-to-ISA Bridge module has three possible configurations: Basic, Stack-UP only, and Stack-DOWN Only. Because of the heights of the Q2 (PCI/104-Express and PCIe/104) connectors and the ISA Bus (PC/104-*Plus*) connector and because they reside in the same general location, interference can occur if a PCI-to-ISA Bridge module is placed next to PCI/104-Express or PCIe/104 module. In this case a Stack-UP Only or a Stack-DOWN Only version must be used. If there is a PCI-104 module between the PCI-to-ISA Bridge module and a PCI/104-Express or PCIe/104 module then a Basic configuration can be used.

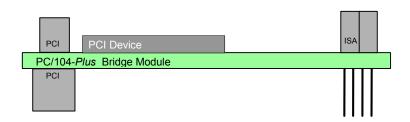


Figure 6-19: Basic Configuration of the PCI-to-ISA Bridge Module

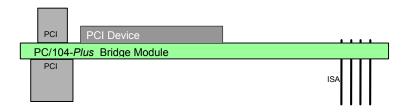


Figure 6-20: Stack-DOWN Configuration of the PCI-to-ISA Bridge Module

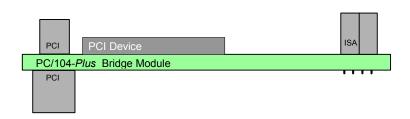


Figure 6-21: Stack-UP Configuration of the PCI-to-ISA Bridge Module

A.2 Stack Configuration Examples

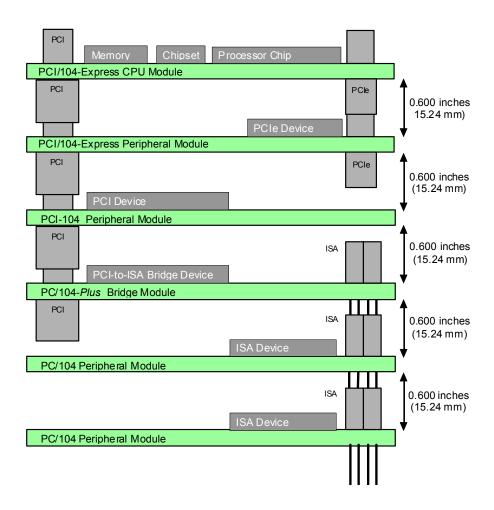


Figure 6-22: Stack-DOWN Configuration Example

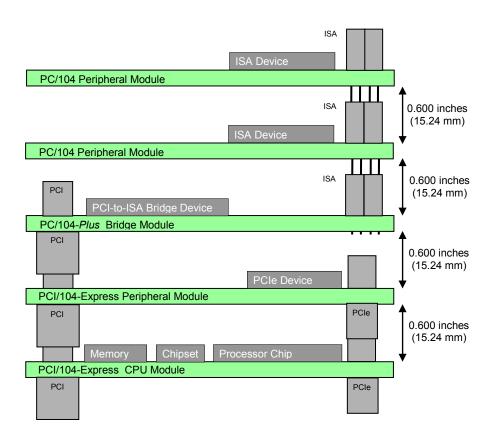


Figure 6-23: Combined Stack-UP Configuration Example

APPENDIX B: EPIC FORM FACTOR – PCI/104-Express Placement

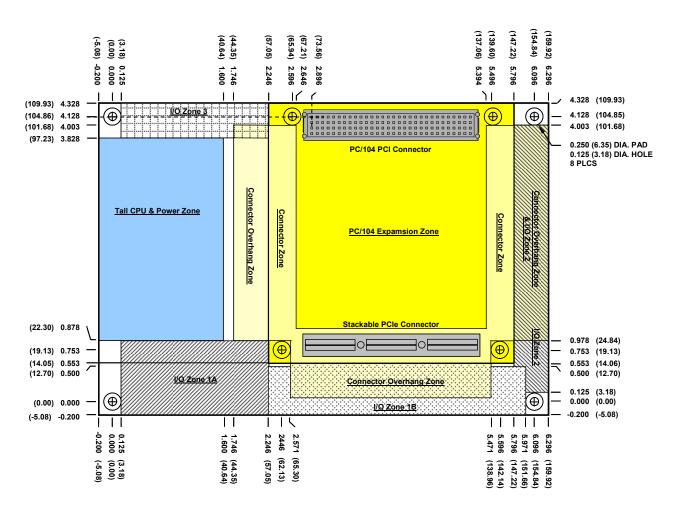


Figure 6-24: EPIC with PCI/104-Express

APPENDIX C: EBX FORM FACTOR – PCI/104-Express Placement

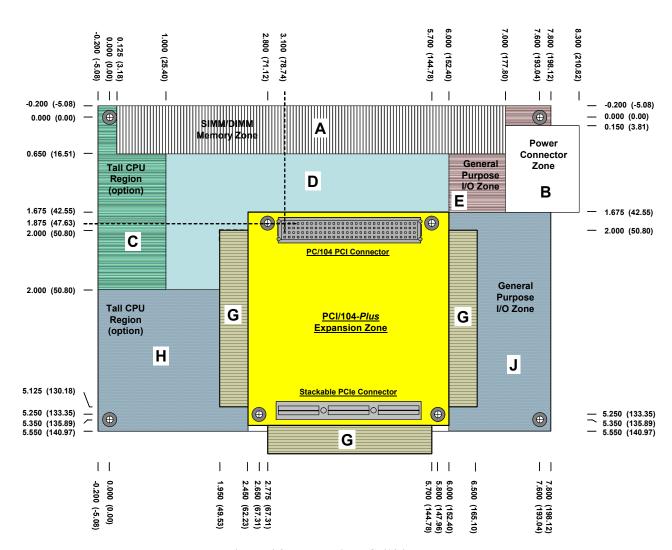


Figure 6-25: EBX with PCI/104-Express